FLASH MEMORY
CMOS
32 M (4M × 8/2M × 16) BIT
MirrorFlash™*

MBM29PL32TM/BM 90/10

■ DESCRIPTION

The MBM29PL32TM/BM is a 32M-bit, 3.0 V-only Flash memory organized as 4M bytes by 8 bits or 2M words by 16 bits. The MBM29PL32TM/BM is offered in 48-pin TSOP(1) and 48-ball FBGA. The device is designed to be programmed in-system with the standard 3.0 V V_{CC} supply. 12.0 V V_{PP} and 5.0 V V_{CC} are not required for write or erase operations. The devices can also be reprogrammed in standard EPROM programmers.

(Continued)

■ PRODUCT LINE UP

Part No.	MBM29PL32TM/BM	
	90	10
V_{CC}	3.0 V to 3.6 V	3.0 V to 3.6 V
Max Address Access Time	90 ns	100 ns
Max $\overline{CE}$ Access Time	90 ns	100 ns
Max Page Read Access Time	25 ns	30 ns

■ PACKAGES

48-pin plastic TSOP (1)

48-ball plastic FBGA

(FPT-48P-M19)

(BGA-48P-M20)
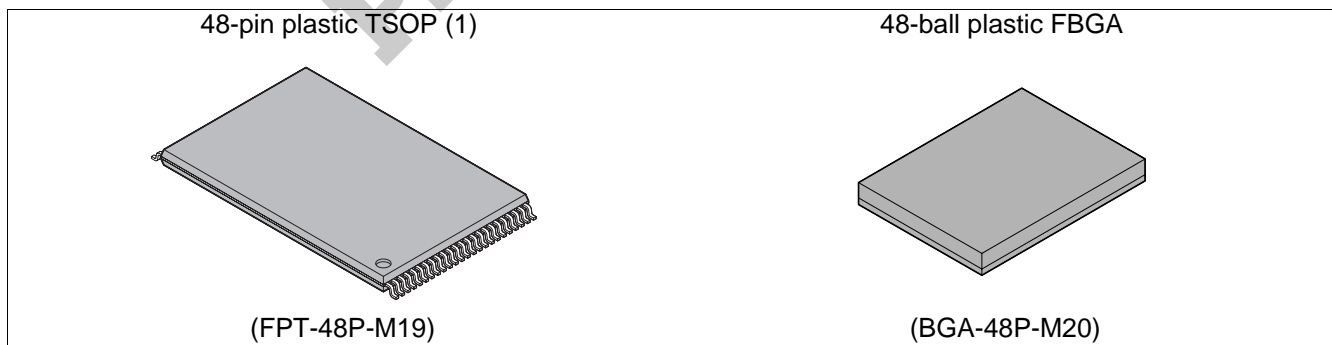
* : MirrorFlash™ is a trademark of Fujitsu Limited.

Notes : • Programming in byte mode (× 8) is prohibited.
      • Programming to the address that already contains data is prohibited.
       (It is mandatory to erase data prior to overprogram on the same address.)

FUJITSU

(Continued)

The standard MBM29PL32TM/BM offers access times of 90 ns, allowing operation of high-speed microprocessors without wait states. To eliminate bus contention the devices have separate chip enable ($\overline{CE}$), write enable ($\overline{WE}$), and output enable ($\overline{OE}$) controls.

The MBM29PL32TM/BM supports command set compatible with JEDEC single-power-supply EEPROMS standard. Commands are written into the command register. The register contents serve as input to an internal state-machine which controls the erase and programming circuitry. Write cycles also internally latch addresses and data needed for the programming and erase operations. Reading data out of the devices is similar to reading from 5.0 V and 12.0 V Flash or EPROM devices.

The MBM29PL32TM/BM is programmed by executing the program command sequence. This will invoke the Embedded Program Algorithm™ which is an internal algorithm that automatically times the program pulse widths and verifies proper cell margin. Erase is accomplished by executing the erase command sequence. This will invoke the Embedded Erase Algorithm™ which is an internal algorithm that automatically preprograms the array if it is not already programmed before executing the erase operation. During erase, the device automatically times the erase pulse widths and verifies proper cell margin.

The device also features a sector erase architecture. The sector mode allows each sector to be erased and reprogrammed without affecting other sectors. All sectors are erased when shipped from the factory.

The device features single 3.0 V power supply operation for both read and write functions. Internally generated and regulated voltages are provided for the program and erase operations. A low V_{CC} detector automatically inhibits write operations on the loss of power. The end of program or erase is detected by $\overline{Data}$ Polling of DQ_7, by the Toggle Bit feature on DQ_6. Once the end of a program or erase cycle has been completed, the devices internally return to the read mode.

Fujitsu Flash technology combines years of Flash memory manufacturing experience to produce the highest levels of quality, reliability, and cost effectiveness. The devices electrically erase all bits within a sector simultaneously via hot-hole assisted erase. The words are programmed one word at a time using the EPROM programming mechanism of hot electron injection.
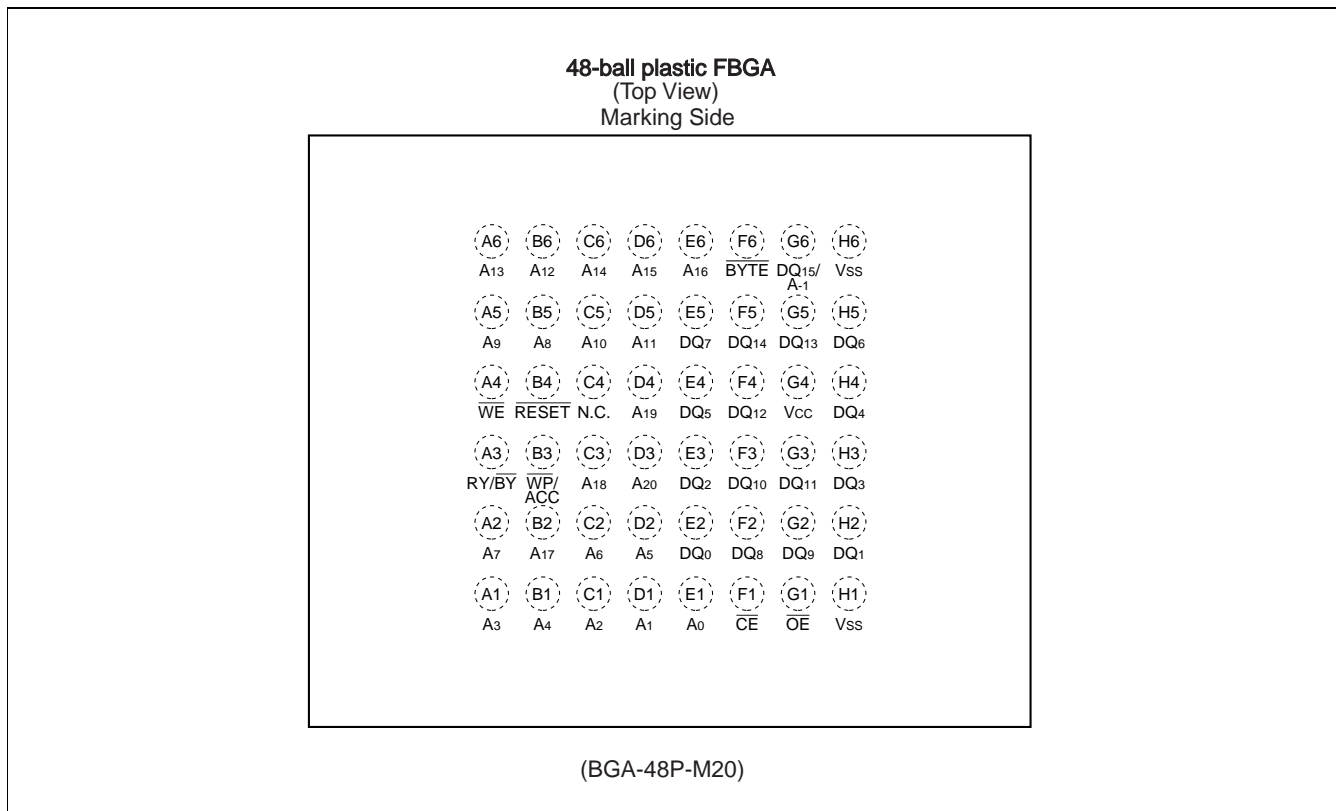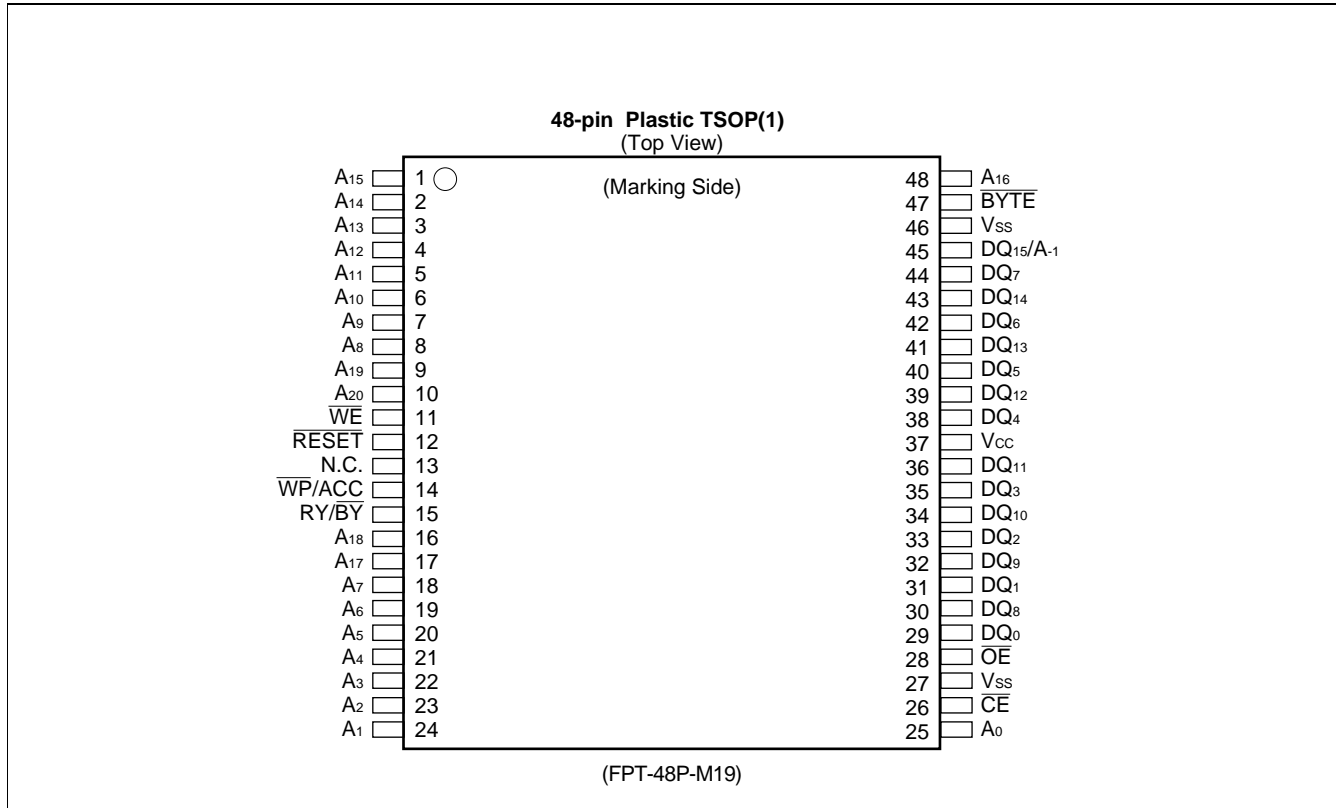
■ FEATURES

- **0.23 μm Process Technology**
- **Single 3.0 V read, program and erase**
  Minimizes system level power requirements
- **Industry-standard pinouts**
  48-pin TSOP (1) (Package suffix: TN - Normal Bend Type)
  48-ball FBGA(Package suffix: PBT)
- **Minimum 100,000 program/erase cycles**
- **High performance Page mode**
  Fast 8 bytes / 4 words access capability
- **Sector erase architecture**
  Eight 8K byte and sixty-three 64K byte sectors
  Eight 4K word and sixty-three 32K word sectors
  Any combination of sectors can be concurrently erased. Also supports full chip erase
- **Boot Code Sector Architecture**
  T = Top sector
  B = Bottom sector
- **HiddenROM**
  256 bytes / 128 words of HiddenROM, accessible through a "HiddenROM Entry" command sequence
  Factory serialized and protected to provide a secure electronic serial number (ESN)
- **$\overline{\text{WP}}$/ACC input pin**
  At V_{IL}, allows protection of outermost two 8K bytes / 4K words sectors, regardless of sector protection/unprotection status
  At V_{ACC}, increases program performance
- **Embedded Erase™* Algorithms**
  Automatically pre-programs and erases the chip or any sector
- **Embedded Program™* Algorithms**
  Automatically writes and verifies data at specified address
- **$\overline{\text{Data}}$ Polling and Toggle Bit feature for detection of program or erase cycle completion**
- **Ready/Busy output (RY/$\overline{\text{BY}}$)**
  Hardware method for detection of program or erase cycle completion
- **Automatic sleep mode**
  When addresses remain stable, automatically switches themselves to low power mode
- **Program Suspend/Resume**
  Suspends the program operation to allow a read in another address
- **Low V_{CC} write inhibit ≤ 2.5 V**
- **Erase Suspend/Resume**
  Suspends the erase operation to allow a read data and/or program in another sector within the same device
- **Sector Group Protection**
  Hardware method disables any combination of sector groups from program or erase operations
- **Sector Group Protection Set function by Extended sector protect command**
- **Fast Programming Function by Extended Command**
- **Temporary sector group unprotection**
  Temporary sector group unprotection via the $\overline{\text{RESET}}$ pin
  This feature allows code changes in previously locked sectors
- **In accordance with CFI (Common Flash Memory Interface)**

* : Embedded Erase™ and Embedded Program™ are trademarks of Advanced Micro Devices, Inc.

■ PIN ASSIGNMENTS

48-pin Plastic TSOP(1)
(Top View)

(Marking Side)

Pin	Signal		Pin	Signal
A$_{15}$	1 ○		48	A$_{16}$
A$_{14}$	2		47	$\overline{BYTE}$
A$_{13}$	3		46	V$_{SS}$
A$_{12}$	4		45	DQ$_{15}$/A$_{-1}$
A$_{11}$	5		44	DQ$_7$
A$_{10}$	6		43	DQ$_{14}$
A$_9$	7		42	DQ$_6$
A$_8$	8		41	DQ$_{13}$
A$_{19}$	9		40	DQ$_5$
A$_{20}$	10		39	DQ$_{12}$
$\overline{WE}$	11		38	DQ$_4$
$\overline{RESET}$	12		37	V$_{CC}$
N.C.	13		36	DQ$_{11}$
$\overline{WP}$/ACC	14		35	DQ$_3$
RY/$\overline{BY}$	15		34	DQ$_{10}$
A$_{18}$	16		33	DQ$_2$
A$_{17}$	17		32	DQ$_9$
A$_7$	18		31	DQ$_1$
A$_6$	19		30	DQ$_8$
A$_5$	20		29	DQ$_0$
A$_4$	21		28	$\overline{OE}$
A$_3$	22		27	V$_{SS}$
A$_2$	23		26	$\overline{CE}$
A$_1$	24		25	A$_0$

(FPT-48P-M19)

48-ball plastic FBGA
(Top View)
Marking Side

A6 A$_{13}$	B6 A$_{12}$	C6 A$_{14}$	D6 A$_{15}$	E6 A$_{16}$	F6 $\overline{BYTE}$	G6 DQ$_{15}$/A$_{-1}$	H6 V$_{SS}$
A5 A$_9$	B5 A$_8$	C5 A$_{10}$	D5 A$_{11}$	E5 DQ$_7$	F5 DQ$_{14}$	G5 DQ$_{13}$	H5 DQ$_6$
A4 $\overline{WE}$	B4 $\overline{RESET}$	C4 N.C.	D4 A$_{19}$	E4 DQ$_5$	F4 DQ$_{12}$	G4 V$_{CC}$	H4 DQ$_4$
A3 RY/$\overline{BY}$	B3 $\overline{WP}$/ACC	C3 A$_{18}$	D3 A$_{20}$	E3 DQ$_2$	F3 DQ$_{10}$	G3 DQ$_{11}$	H3 DQ$_3$
A2 A$_7$	B2 A$_{17}$	C2 A$_6$	D2 A$_5$	E2 DQ$_0$	F2 DQ$_8$	G2 DQ$_9$	H2 DQ$_1$
A1 A$_3$	B1 A$_4$	C1 A$_2$	D1 A$_1$	E1 A$_0$	F1 $\overline{CE}$	G1 $\overline{OE}$	H1 V$_{SS}$

(BGA-48P-M20)

■ PIN DESCRIPTIONS

MBM29PL32TM/BM Pin Configuration

Pin	Function
A_{20} to A_0, A_{-1}	Address Inputs
DQ_{15} to DQ_0	Data Inputs/Outputs
$\overline{CE}$	Chip Enable
$\overline{OE}$	Output Enable
$\overline{WE}$	Write Enable
$\overline{WP}$/ACC	Hardware Write Protection/Program Acceleration
$\overline{RESET}$	Hardware Reset Pin/Temporary Sector Group Unprotection
$\overline{BYTE}$	Select Byte or Word mode
RY/$\overline{BY}$	Ready/Busy Output
V_{CC}	Device Power Supply
V_{SS}	Device Ground
N.C.	No Internal Connection

■ BLOCK DIAGRAM
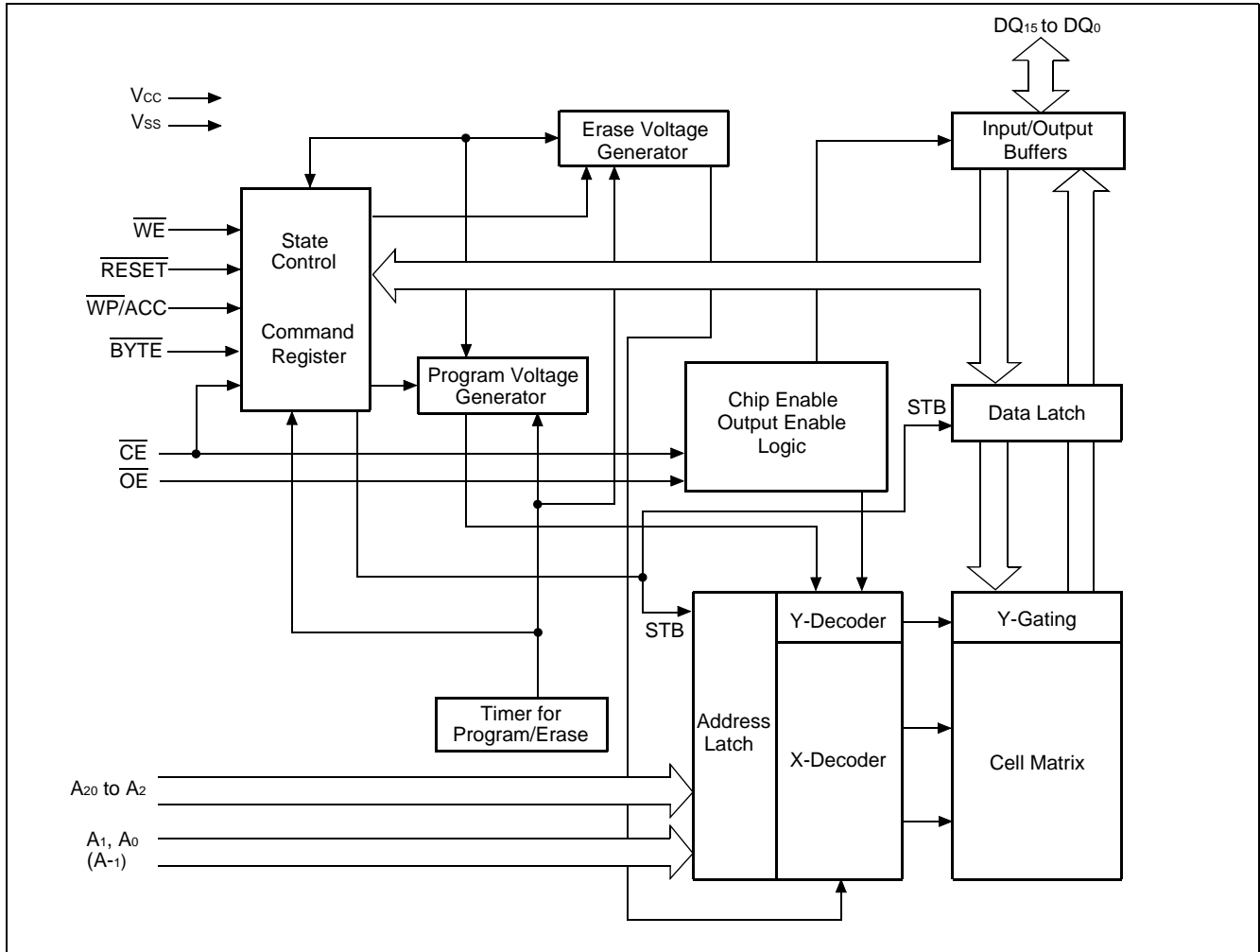
■ LOGIC SYMBOL
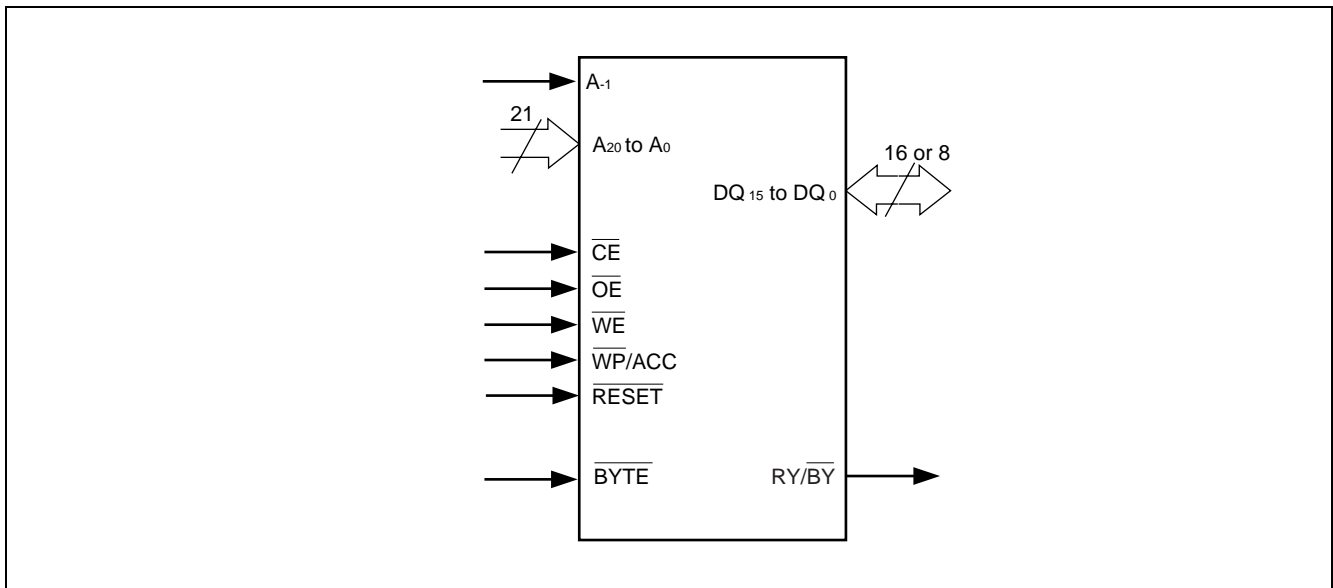
■ DEVICE BUS OPERATION

MBM29PL32TM/BM User Bus Operations (Word Mode : $\overline{\text{BYTE}}$ = V_{IH})

Operation	$\overline{\text{CE}}$	$\overline{\text{OE}}$	$\overline{\text{WE}}$	A_0	A_1	A_2	A_3	A_6	A_9	DQ_0 to DQ_{15}	$\overline{\text{RESET}}$	$\overline{\text{WP}}$/ACC
Standby	H	X	X	X	X	X	X	X	X	Hi-Z	H	X
Autoselect Manufacture Code[1]	L	L	H	L	L	L	L	L	V_{ID}	Code	H	X
Autoselect Device Code[1]	L	L	H	H	L	L	L	L	V_{ID}	Code	H	X
Read	L	L	H	A_0	A_1	A_2	A_3	A_6	A_9	D_{OUT}	H	X
Output Disable	L	H	H	X	X	X	X	X	X	Hi-Z	H	X
Write (Program/Erase)	L	H	L	A_0	A_1	A_2	A_3	A_6	A_9	[3]	H	[4]
Enable Sector Group Protection[2]	L	H	L	L	H	L	L	L	X	[3]	V_{ID}	H
Temporary Sector Group Unprotection	X	X	X	X	X	X	X	X	X	[3]	V_{ID}	H
Reset (Hardware)	X	X	X	X	X	X	X	X	X	Hi-Z	L	X
Sector Write Protection	X	X	X	X	X	X	X	X	X	X	H	L

Legend : L = V_{IL}, H = V_{IH}, X = V_{IL} or V_{IH}. See "■ ELECTRICAL CHARACTERISTICS 1. DC Characteristics" for voltage levels.
Hi-Z = High-Z, V_{ID} = 11.5 V to 12.5 V

[1] : Manufacturer and device codes may also be accessed via a command register write sequence.
See "Sector Group Protection Verify Autoselect Codes".

[2] : Refer to "Sector Group Protection" in ■ FUNCTIONAL DESCRIPTION.

[3] : D_{IN} or D_{OUT} as required by command sequence, data pulling, or sector protect algorithm

[4] : If $\overline{\text{WP}}$/ACC = V_{IL}, the outermost two sectors remain protected.
If $\overline{\text{WP}}$/ACC = V_{IH}, the outermost two sectors will be protected or unprotected as determined by the method specified in "Sector Group Protection" in ■ FUNCTIONAL DESCRIPTION.

MBM29PL32TM/BM User Bus Operations (Byte Mode : $\overline{BYTE}$ = V_{IL})

Operation	$\overline{CE}$	$\overline{OE}$	$\overline{WE}$	DQ$_{15}$/A$_{-1}$	A$_0$	A$_1$	A$_2$	A$_3$	A$_6$	A$_9$	DQ$_0$ to DQ$_7$	$\overline{RESET}$	$\overline{WP}$/ACC
Standby	H	X	X	X	X	X	X	X	X	X	Hi-Z	H	X
Autoselect Manufacture Code*1	L	L	H	L	L	L	L	L	L	V_{ID}	Code	H	X
Autoselect Device Code*1	L	L	H	L	H	L	L	L	L	V_{ID}	Code	H	X
Read	L	L	H	A$_{-1}$	A$_0$	A$_1$	A$_2$	A$_3$	A$_6$	A$_9$	D$_{OUT}$	H	X
Output Disable	L	H	H	X	X	X	X	X	X	X	Hi-Z	H	X
Write (Erase)	L	H	L	A$_{-1}$	A$_0$	A$_1$	A$_2$	A$_3$	A$_6$	A$_9$	*3	H	*4
Enable Sector Group Protection*2	L	H	L	L	L	H	L	L	L	X	*3	V_{ID}	H
Temporary Sector Group Unprotection	X	X	X	X	X	X	X	X	X	X	*3	V_{ID}	H
Reset (Hardware)	X	X	X	X	X	X	X	X	X	X	Hi-Z	L	X
Sector Write Protection	X	X	X	X	X	X	X	X	X	X	X	H	L

Legend : L = V_{IL}, H = V_{IH}, X = V_{IL} or V_{IH}. See "■ ELECTRICAL CHARACTERISTICS 1. DC Characteristics" for voltage levels.
Hi-Z = High-Z, V_{ID} = 11.5 V to 12.5 V

*1 : Manufacturer and device codes may also be accessed via a command register write sequence.
See "MBM29PL32TM/BM Standard Command Definitions".

*2 : Refer to "Sector Group Protection".

*3 : D$_{IN}$ or D$_{OUT}$ as required by command sequence, data pulling, or sector protect algorithm

*4 : If $\overline{WP}$/ACC = V_{IL}, the outermost two sectors remain protected.
If $\overline{WP}$/ACC = V_{IH}, the outermost two sectors will be protected or unprotected as determined by the method specified in "Sector Group Protection" in page 23.

MBM29PL32TM/BM Standard Command Definitions*1

Command Sequence		Bus Write Cycles Req'd	First Bus Write Cycle		Second Bus Write Cycle		Third Bus Write Cycle		Fourth Bus Read/Write Cycle		Fifth Bus Write Cycle		Sixth Bus Write Cycle	
			Addr	Data	Addr	Data	Addr	Data	Addr	Data	Addr	Data	Addr	Data
Reset*2	Word/Byte	1	XXXh	F0h	—	—	—	—	—	—	—	—	—	—
Reset*2	Word	3	555h	AAh	2AAh	55h	555h	F0h	RA*13	RD*13	—	—	—	—
	Byte		AAAh		555h		AAAh							
Autoselect	Word	3	555h	AAh	2AAh	55h	555h	90h	00h*13	04h*13	—	—	—	—
	Byte		AAAh		555h		AAAh							
Program	Word	4	555h	AAh	2AAh	55h	555h	A0h	PA	PD	—	—	—	—
Chip Erase	Word	6	555h	AAh	2AAh	55h	555h	80h	555h	AAh	2AAh	55h	555h	10h
	Byte		AAAh		555h		AAAh		AAAh		555h		AAAh	
Sector Erase	Word	6	555h	AAh	2AAh	55h	555h	80h	555h	AAh	2AAh	55h	SA	30h
	Byte		AAAh		555h		AAAh		AAAh		555h			
Program/Erase Suspend*3		1	XXXh	B0h	—	—	—	—	—	—	—	—	—	—
Program/Erase Resume*3		1	XXXh	30h	—	—	—	—	—	—	—	—	—	—
Set to Fast Mode*4	Word	3	555h	AAh	2AAh	55h	555h	20h	—	—	—	—	—	—
	Byte		AAAh		555h		AAAh							
Fast Program*4	Word	2	XXXh	A0h	PA	PD	—	—	—	—	—	—	—	—
Reset from Fast Mode*5	Word/Byte	2	XXXh	90h	XXXh	00h*12	—	—	—	—	—	—	—	—
Write to Buffer	Word	20	555h	AAh	2AAh	55h	SA	25h	SA	0Fh	PA	PD	WBL	PD
	Byte		AAAh		555h									
Program Buffer to Flash (Confirm)		1	SA	29h	—	—	—	—	—	—	—	—	—	—
Write to Buffer Abort Reset*6	Word	3	555h	AAh	2AAh	55h	555h	F0h	—	—	—	—	—	—
	Byte		AAAh		555h		AAAh							
Extended Sector Group Protection*7,*8	Word Byte	4	XXXh	60h	SGA	60h	SGA	40h	SGA*13	SD*13	—	—	—	—
Query*9	Word	1	55h	98h	—	—	—	—	—	—	—	—	—	—
	Byte		AAh											
HiddenROM Entry*10	Word	3	555h	AAh	2AAh	55h	555h	88h	—	—	—	—	—	—
	Byte		AAAh		555h		AAAh							
HiddenROM Program *10,*11	Word	4	555h	AAh	2AAh	55h	555h	A0h	PA	PD	—	—	—	—
	Byte		AAAh		555h		AAAh							
HiddenROM Exit*11	Word	4	555h	AAh	2AAh	55h	555h	90h	XXXh	00h	—	—	—	—
	Byte		AAAh		555h		AAAh							

(Continued)

9

(Continued)

Legend : Address bits A_{20} to A_{11} = X = "H" or "L" for all address commands except for Program Address (PA),
Sector Address (SA) and Sector Group Address (SGA).
Bus operations are defined in "MBM29PL32TM/BM User Bus Operations (Word Mode : BYTE = V_{IH})"
and "MBM29PL32TM/BM User Bus Operations (Byte Mode : BYTE = V_{IL})".

RA   = Address of the memory location to be read.

PA   = Address of the memory location to be programmed. Addresses are latched on the falling edge of the write pulse.

SA   = Address of the sector to be programmed / erased. The combination of A_{20}, A_{19}, A_{18}, A_{17}, A_{16}, A_{15}, A_{14}, A_{13} and A_{12} will uniquely select any sector. See "Sector Address Table (MBM29PL32TM)" and "Sector Address Table (MBM29PL32BM)".

SGA = Sector Group Address to be protected. See "Sector Group Address Table (MBM29PL32TM)" and "Sector Group Address Table (MBM29PL32BM)".

RD   = Data read from location RA during read operation.

PD   = Data to be programmed at location PA. Data is latched on the rising edge of write plus.

WBL = Write Buffer Location

HRA = Address of the HiddenROM area ;
        MBM29PL32TM (Top Boot Type)Word Mode : 1FFF7Fh to 1FFFFFh
                                          Byte Mode   : 3FFEFFh to 3FFFFFh
        MBM29PL32BM (Bottom Boot Type)Word Mode : 000000h to 00007Fh
                                            Byte Mode   : 000000h to 0000FFh

*1   : The command combinations not described in "MBM29PL32TM/BM Standard Command Definitions" are illegal.

*2   : Both of these reset commands are equivalent except for "Write to Buffer Abort" reset.

*3   : The Erase Suspend and Erase Resume command are valid only during a sector erase operation.

*4   : The Set to Fast Mode command is required prior to the Fast Program command.

*5   : The Reset from Fast Mode command is required to return to the read mode when the device is in fast mode.

*6   : Reset to the read mode. The Write to Buffer Abort Reset command is required after the Write to Buffer operation was aborted.

*7   : This command is valid while $\overline{RESET}$ = V_{ID}.

*8   : Sector Group Address (SGA) with A_6 = 0, A_3 = 0, A_2 = 0, A_1 = 1, and A_0 = 0

*9   : The valid address are A_6 to A_0.

*10 : The HiddenROM Entry command is required prior to the HiddenROM programming.

*11 : This command is valid during HiddenROM mode.

*12 : The data "F0h" is also acceptable.

*13 : Indicates read cycle.

Sector Group Protection Verify Autoselect Codes

Type			A_{20} to A_{12}	A_6	A_3	A_2	A_1	A_0	A_{-1}*1	Code (HEX)
Manufacturer's Code			X	V_{IL}	V_{IL}	V_{IL}	V_{IL}	V_{IL}	V_{IL}	04h
Device Code	Word		X	V_{IL}	V_{IL}	V_{IL}	V_{IL}	V_{IH}	X	227Eh
	Byte								V_{IL}	7Eh
Extended Device Code*2	MBM29PL32TM	Word	X	V_{IL}	V_{IH}	V_{IH}	V_{IH}	V_{IL}	X	221Ah
		Byte							V_{IL}	1Ah
		Word	X	V_{IL}	V_{IH}	V_{IH}	V_{IH}	V_{IH}	X	2201h
		Byte							V_{IL}	01h
	MBM29PL32BM	Word	X	V_{IL}	V_{IH}	V_{IH}	V_{IH}	V_{IL}	X	221Ah
		Byte							V_{IL}	1Ah
		Word	X	V_{IL}	V_{IH}	V_{IH}	V_{IH}	V_{IH}	X	2200h
		Byte							V_{IL}	00h
Sector Group Protection*4			Sector Group Addresses	V_{IL}	V_{IL}	V_{IL}	V_{IH}	V_{IL}	V_{IL}	*3

*1 : A_{-1} is for Byte mode.

*2 : At Word mode, a read cycle at address 01h (at Byte mode, 02h) outputs device code. When 227Eh (at Byte mode, 7Eh) is output, it indicates that reading two additional codes, called Extended Device Codes, will be required. Therefore the system may continue reading out these Extended Device Codes at the address of 0Eh (at Byte mode, 1Ch), as well as at 0Fh (at Byte mode, 1Eh).

*3 : Outputs 01h at protected sector group addresses and outputs 00h at unprotected sector group addresses.

*4 : Toggle $\overline{CE}$, provided SGA = fix and $\overline{WE}$ = fix.
The data in the first cycle is invalid. The data in the second one is valid.

Sector Address Table (MBM29PL32TM)

Sector	Sector Address									Sector Size (Kbytes/ Kwords)	(×8) Address Range	(×16) Address Range
	A_{20}	A_{19}	A_{18}	A_{17}	A_{16}	A_{15}	A_{14}	A_{13}	A_{12}			
SA0	0	0	0	0	0	0	X	X	X	64/32	000000h to 00FFFFh	000000h to 007FFFh
SA1	0	0	0	0	0	1	X	X	X	64/32	010000h to 01FFFFh	008000h to 00FFFFh
SA2	0	0	0	0	1	0	X	X	X	64/32	020000h to 02FFFFh	010000h to 017FFFh
SA3	0	0	0	0	1	1	X	X	X	64/32	030000h to 03FFFFh	018000h to 01FFFFh
SA4	0	0	0	1	0	0	X	X	X	64/32	040000h to 04FFFFh	020000h to 027FFFh
SA5	0	0	0	1	0	1	X	X	X	64/32	050000h to 05FFFFh	028000h to 02FFFFh
SA6	0	0	0	1	1	0	X	X	X	64/32	060000h to 06FFFFh	030000h to 037FFFh
SA7	0	0	0	1	1	1	X	X	X	64/32	070000h to 07FFFFh	038000h to 03FFFFh
SA8	0	0	1	0	0	0	X	X	X	64/32	080000h to 08FFFFh	040000h to 047FFFh
SA9	0	0	1	0	0	1	X	X	X	64/32	090000h to 09FFFFh	048000h to 04FFFFh
SA10	0	0	1	0	1	0	X	X	X	64/32	0A0000h to 0AFFFFh	050000h to 057FFFh
SA11	0	0	1	0	1	1	X	X	X	64/32	0B0000h to 0BFFFFh	058000h to 05FFFFh
SA12	0	0	1	1	0	0	X	X	X	64/32	0C0000h to 0CFFFFh	060000h to 067FFFh
SA13	0	0	1	1	0	1	X	X	X	64/32	0D0000h to 0DFFFFh	068000h to 06FFFFh
SA14	0	0	1	1	1	0	X	X	X	64/32	0E0000h to 0EFFFFh	070000h to 077FFFh
SA15	0	0	1	1	1	1	X	X	X	64/32	0F0000h to 0FFFFFh	078000h to 07FFFFh
SA16	0	1	0	0	0	0	X	X	X	64/32	100000h to 10FFFFh	080000h to 087FFFh
SA17	0	1	0	0	0	1	X	X	X	64/32	110000h to 11FFFFh	088000h to 08FFFFh
SA18	0	1	0	0	1	0	X	X	X	64/32	120000h to 12FFFFh	090000h to 097FFFh
SA19	0	1	0	0	1	1	X	X	X	64/32	130000h to 13FFFFh	098000h to 09FFFFh
SA20	0	1	0	1	0	0	X	X	X	64/32	140000h to 14FFFFh	0A0000h to 0A7FFFh
SA21	0	1	0	1	0	1	X	X	X	64/32	150000h to 15FFFFh	0A8000h to 0AFFFFh
SA22	0	1	0	1	1	0	X	X	X	64/32	160000h to 16FFFFh	0B0000h to 0B7FFFh
SA23	0	1	0	1	1	1	X	X	X	64/32	170000h to 17FFFFh	0B8000h to 0BFFFFh
SA24	0	1	1	0	0	0	X	X	X	64/32	180000h to 18FFFFh	0C0000h to 0C7FFFh
SA25	0	1	1	0	0	1	X	X	X	64/32	190000h to 19FFFFh	0C8000h to 0CFFFFh
SA26	0	1	1	0	1	0	X	X	X	64/32	1A0000h to 1AFFFFh	0D0000h to 0D7FFFh
SA27	0	1	1	0	1	1	X	X	X	64/32	1B0000h to 1BFFFFh	0D8000h to 0DFFFFh
SA28	0	1	1	1	0	0	X	X	X	64/32	1C0000h to 1CFFFFh	0E0000h to 0E7FFFh
SA29	0	1	1	1	0	1	X	X	X	64/32	1D0000h to 1DFFFFh	0E8000h to 0EFFFFh
SA30	0	1	1	1	1	0	X	X	X	64/32	1E0000h to 1EFFFFh	0F0000h to 0F7FFFh
SA31	0	1	1	1	1	1	X	X	X	64/32	1F0000h to 1FFFFFh	0F8000h to 0FFFFFh

(Continued)

Sector	Sector Address									Sector Size (Kbytes/ Kwords)	(×8) Address Range	(×16) Address Range
	A_{20}	A_{19}	A_{18}	A_{17}	A_{16}	A_{15}	A_{14}	A_{13}	A_{12}			
SA32	1	0	0	0	0	0	X	X	X	64/32	200000h to 20FFFFh	100000h to 107FFFh
SA33	1	0	0	0	0	1	X	X	X	64/32	210000h to 21FFFFh	108000h to 10FFFFh
SA34	1	0	0	0	1	0	X	X	X	64/32	220000h to 22FFFFh	110000h to 117FFFh
SA35	1	0	0	0	1	1	X	X	X	64/32	230000h to 23FFFFh	118000h to 11FFFFh
SA36	1	0	0	1	0	0	X	X	X	64/32	240000h to 24FFFFh	120000h to 127FFFh
SA37	1	0	0	1	0	1	X	X	X	64/32	250000h to 25FFFFh	128000h to 12FFFFh
SA38	1	0	0	1	1	0	X	X	X	64/32	260000h to 26FFFFh	130000h to 137FFFh
SA39	1	0	0	1	1	1	X	X	X	64/32	270000h to 27FFFFh	138000h to 13FFFFh
SA40	1	0	1	0	0	0	X	X	X	64/32	280000h to 28FFFFh	140000h to 147FFFh
SA41	1	0	1	0	0	1	X	X	X	64/32	290000h to 29FFFFh	148000h to 14FFFFh
SA42	1	0	1	0	1	0	X	X	X	64/32	2A0000h to 2AFFFFh	150000h to 157FFFh
SA43	1	0	1	0	1	1	X	X	X	64/32	2B0000h to 2BFFFFh	158000h to 15FFFFh
SA44	1	0	1	1	0	0	X	X	X	64/32	2C0000h to 2CFFFFh	160000h to 167FFFh
SA45	1	0	1	1	0	1	X	X	X	64/32	2D0000h to 2DFFFFh	168000h to 16FFFFh
SA46	1	0	1	1	1	0	X	X	X	64/32	2E0000h to 2EFFFFh	170000h to 177FFFh
SA47	1	0	1	1	1	1	X	X	X	64/32	2F0000h to 2FFFFFh	178000h to 17FFFFh
SA48	1	1	0	0	0	0	X	X	X	64/32	300000h to 30FFFFh	180000h to 187FFFh
SA49	1	1	0	0	0	1	X	X	X	64/32	310000h to 31FFFFh	188000h to 18FFFFh
SA50	1	1	0	0	1	0	X	X	X	64/32	320000h to 32FFFFh	190000h to 197FFFh
SA51	1	1	0	0	1	1	X	X	X	64/32	330000h to 33FFFFh	198000h to 19FFFFh
SA52	1	1	0	1	0	0	X	X	X	64/32	340000h to 34FFFFh	1A0000h to 1A7FFFh
SA53	1	1	0	1	0	1	X	X	X	64/32	350000h to 35FFFFh	1A8000h to 1AFFFFh
SA54	1	1	0	1	1	0	X	X	X	64/32	360000h to 36FFFFh	1B0000h to 1B7FFFh
SA55	1	1	0	1	1	1	X	X	X	64/32	370000h to 37FFFFh	1B8000h to 1BFFFFh
SA56	1	1	1	0	0	0	X	X	X	64/32	380000h to 38FFFFh	1C0000h to 1C7FFFh
SA57	1	1	1	0	0	1	X	X	X	64/32	390000h to 39FFFFh	1C8000h to 1CFFFFh
SA58	1	1	1	0	1	0	X	X	X	64/32	3A0000h to 3AFFFFh	1D0000h to 1D7FFFh
SA59	1	1	1	0	1	1	X	X	X	64/32	3B0000h to 3BFFFFh	1D8000h to 1DFFFFh
SA60	1	1	1	1	0	0	X	X	X	64/32	3C0000h to 3CFFFFh	1E0000h to 1E7FFFh
SA61	1	1	1	1	0	1	X	X	X	64/32	3D0000h to 3DFFFFh	1E8000h to 1EFFFFh
SA62	1	1	1	1	1	0	X	X	X	64/32	3E0000h to 3EFFFFh	1F0000h to 1F7FFFh
SA63	1	1	1	1	1	1	0	0	0	8/4	3F0000h to 3F1FFFh	1F8000h to 1F8FFFh
SA64	1	1	1	1	1	1	0	0	1	8/4	3F2000h to 3F3FFFh	1F9000h to 1F9FFFh

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Sector	Sector Address									Sector Size (Kbytes/ Kwords)	(×8) Address Range	(×16) Address Range
	A20	A19	A18	A17	A16	A15	A14	A13	A12			
SA65	1	1	1	1	1	1	0	1	0	8/4	3F4000h to 3F5FFFh	1FA000h to 1FAFFFh
SA66	1	1	1	1	1	1	0	1	1	8/4	3F6000h to 3F7FFFh	1FB000h to 1FBFFFh
SA67	1	1	1	1	1	1	1	0	0	8/4	3F8000h to 3F9FFFh	1FC000h to 1FCFFFh
SA68	1	1	1	1	1	1	1	0	1	8/4	3FA000h to 3FBFFFh	1FD000h to 1FDFFFh
SA69	1	1	1	1	1	1	1	1	0	8/4	3FC000h to 3FDFFFh	1FE000h to 1FEFFFh
SA70	1	1	1	1	1	1	1	1	1	8/4	3FE000h to 3FFFFFh	1FF000h to 1FFFFFh

Note : The address range is A_{20} to A_{-1} if in Byte mode ($\overline{BYTE}$ = V_{IL}) .
The address range is A_{20} to A_0 if in Word mode ($\overline{BYTE}$ = V_{IH}) .

Sector Address Table (MBM29PL32BM)

Sector	Sector Address									Sector Size (Kbytes/ Kwords)	(×8) Address Range	(×16) Address Range
	A_{20}	A_{19}	A_{18}	A_{17}	A_{16}	A_{15}	A_{14}	A_{13}	A_{12}			
SA70	1	1	1	1	1	1	X	X	X	64/32	3F0000h to 3FFFFFh	1F8000h to 1FFFFFh
SA69	1	1	1	1	1	0	X	X	X	64/32	3E0000h to 3EFFFFh	1F0000h to 1F7FFFh
SA68	1	1	1	1	0	1	X	X	X	64/32	3D0000h to 3DFFFFh	1E8000h to 1EFFFFh
SA67	1	1	1	1	0	0	X	X	X	64/32	3C0000h to 3CFFFFh	1E0000h to 1E7FFFh
SA66	1	1	1	0	1	1	X	X	X	64/32	3B0000h to 3BFFFFh	1D8000h to 1DFFFFh
SA65	1	1	1	0	1	0	X	X	X	64/32	3A0000h to 3AFFFFh	1D0000h to 1D7FFFh
SA64	1	1	1	0	0	1	X	X	X	64/32	390000h to 39FFFFh	1C8000h to 1CFFFFh
SA63	1	1	1	0	0	0	X	X	X	64/32	380000h to 38FFFFh	1C0000h to 1C7FFFh
SA62	1	1	0	1	1	1	X	X	X	64/32	370000h to 37FFFFh	1B8000h to 1BFFFFh
SA61	1	1	0	1	1	0	X	X	X	64/32	360000h to 36FFFFh	1B0000h to 1B7FFFh
SA60	1	1	0	1	0	1	X	X	X	64/32	350000h to 35FFFFh	1A8000h to 1AFFFFh
SA59	1	1	0	1	0	0	X	X	X	64/32	340000h to 34FFFFh	1A0000h to 1A7FFFh
SA58	1	1	0	0	1	1	X	X	X	64/32	330000h to 33FFFFh	198000h to 19FFFFh
SA57	1	1	0	0	1	0	X	X	X	64/32	320000h to 32FFFFh	190000h to 197FFFh
SA56	1	1	0	0	0	1	X	X	X	64/32	310000h to 31FFFFh	188000h to 18FFFFh
SA55	1	1	0	0	0	0	X	X	X	64/32	300000h to 30FFFFh	180000h to 187FFFh
SA54	1	0	1	1	1	1	X	X	X	64/32	2F0000h to 2FFFFFh	178000h to 17FFFFh
SA53	1	0	1	1	1	0	X	X	X	64/32	2E0000h to 2EFFFFh	170000h to 177FFFh
SA52	1	0	1	1	0	1	X	X	X	64/32	2D0000h to 2DFFFFh	168000h to 16FFFFh
SA51	1	0	1	1	0	0	X	X	X	64/32	2C0000h to 2CFFFFh	160000h to 167FFFh
SA50	1	0	1	0	1	1	X	X	X	64/32	2B0000h to 2BFFFFh	158000h to 15FFFFh
SA49	1	0	1	0	1	0	X	X	X	64/32	2A0000h to 2AFFFFh	150000h to 157FFFh
SA48	1	0	1	0	0	1	X	X	X	64/32	290000h to 29FFFFh	148000h to 14FFFFh
SA47	1	0	1	0	0	0	X	X	X	64/32	280000h to 28FFFFh	140000h to 147FFFh
SA46	1	0	0	1	1	1	X	X	X	64/32	270000h to 27FFFFh	138000h to 13FFFFh
SA45	1	0	0	1	1	0	X	X	X	64/32	260000h to 26FFFFh	130000h to 137FFFh
SA44	1	0	0	1	0	1	X	X	X	64/32	250000h to 25FFFFh	128000h to 12FFFFh
SA43	1	0	0	1	0	0	X	X	X	64/32	240000h to 24FFFFh	120000h to 127FFFh
SA42	1	0	0	0	1	1	X	X	X	64/32	230000h to 23FFFFh	118000h to 11FFFFh
SA41	1	0	0	0	1	0	X	X	X	64/32	220000h to 22FFFFh	110000h to 117FFFh
SA40	1	0	0	0	0	1	X	X	X	64/32	210000h to 21FFFFh	108000h to 10FFFFh
SA39	1	0	0	0	0	0	X	X	X	64/32	200000h to 20FFFFh	100000h to 107FFFh
SA38	0	1	1	1	1	1	X	X	X	64/32	1F0000h to 1FFFFFh	0F8000h to 0FFFFFh

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Sector	Sector Address									Sector Size (Kbytes/ Kwords)	(×8) Address Range	(×16) Address Range
	A_{20}	A_{19}	A_{18}	A_{17}	A_{16}	A_{15}	A_{14}	A_{13}	A_{12}			
SA37	0	1	1	1	1	0	X	X	X	64/32	1E0000h to 1EFFFFh	0F0000h to 0F7FFFh
SA36	0	1	1	1	0	1	X	X	X	64/32	1D0000h to 1DFFFFh	0E8000h to 0EFFFFh
SA35	0	1	1	1	0	0	X	X	X	64/32	1C0000h to 1CFFFFh	0E0000h to 0E7FFFh
SA34	0	1	1	0	1	1	X	X	X	64/32	1B0000h to 1BFFFFh	0D8000h to 0DFFFFh
SA33	0	1	1	0	1	0	X	X	X	64/32	1A0000h to 1AFFFFh	0D0000h to 0D7FFFh
SA32	0	1	1	0	0	1	X	X	X	64/32	190000h to 19FFFFh	0C8000h to 0CFFFFh
SA31	0	1	1	0	0	0	X	X	X	64/32	180000h to 18FFFFh	0C0000h to 0C7FFFh
SA30	0	1	0	1	1	1	X	X	X	64/32	170000h to 17FFFFh	0B8000h to 0BFFFFh
SA29	0	1	0	1	1	0	X	X	X	64/32	160000h to 16FFFFh	0B0000h to 0B7FFFh
SA28	0	1	0	1	0	1	X	X	X	64/32	150000h to 15FFFFh	0A8000h to 0AFFFFh
SA27	0	1	0	1	0	0	X	X	X	64/32	140000h to 14FFFFh	0A0000h to 0A7FFFh
SA26	0	1	0	0	1	1	X	X	X	64/32	130000h to 13FFFFh	098000h to 09FFFFh
SA25	0	1	0	0	1	0	X	X	X	64/32	120000h to 12FFFFh	090000h to 097FFFh
SA24	0	1	0	0	0	1	X	X	X	64/32	110000h to 11FFFFh	088000h to 08FFFFh
SA23	0	1	0	0	0	0	X	X	X	64/32	100000h to 10FFFFh	080000h to 087FFFh
SA22	0	0	1	1	1	1	X	X	X	64/32	0F0000h to 0FFFFFh	078000h to 07FFFFh
SA21	0	0	1	1	1	0	X	X	X	64/32	0E0000h to 0EFFFFh	070000h to 077FFFh
SA20	0	0	1	1	0	1	X	X	X	64/32	0D0000h to 0DFFFFh	068000h to 06FFFFh
SA19	0	0	1	1	0	0	X	X	X	64/32	0C0000h to 0CFFFFh	060000h to 067FFFh
SA18	0	0	1	0	1	1	X	X	X	64/32	0B0000h to 0BFFFFh	058000h to 05FFFFh
SA17	0	0	1	0	1	0	X	X	X	64/32	0A0000h to 0AFFFFh	050000h to 057FFFh
SA16	0	0	1	0	0	1	X	X	X	64/32	090000h to 09FFFFh	048000h to 04FFFFh
SA15	0	0	1	0	0	0	X	X	X	64/32	080000h to 08FFFFh	040000h to 047FFFh
SA14	0	0	0	1	1	1	X	X	X	64/32	070000h to 07FFFFh	038000h to 03FFFFh
SA13	0	0	0	1	1	0	X	X	X	64/32	060000h to 06FFFFh	030000h to 037FFFh
SA12	0	0	0	1	0	1	X	X	X	64/32	050000h to 05FFFFh	028000h to 02FFFFh
SA11	0	0	0	1	0	0	X	X	X	64/32	040000h to 04FFFFh	020000h to 027FFFh
SA10	0	0	0	0	1	1	X	X	X	64/32	030000h to 03FFFFh	018000h to 01FFFFh
SA9	0	0	0	0	1	0	X	X	X	64/32	020000h to 02FFFFh	010000h to 017FFFh
SA8	0	0	0	0	0	1	X	X	X	64/32	010000h to 01FFFFh	008000h to 00FFFFh
SA7	0	0	0	0	0	0	1	1	1	8/4	00E000h to 00FFFFh	007000h to 007FFFh
SA6	0	0	0	0	0	0	1	1	0	8/4	00C000h to 00DFFFh	006000h to 006FFFh
SA5	0	0	0	0	0	0	1	0	1	8/4	00A000h to 00BFFFh	005000h to 005FFFh

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Sector	Sector Address									Sector Size (Kbytes/Kwords)	(×8) Address Range	(×16) Address Range
	A_{20}	A_{19}	A_{18}	A_{17}	A_{16}	A_{15}	A_{14}	A_{13}	A_{12}			
SA4	0	0	0	0	0	0	1	0	0	8/4	008000h to 009FFFh	004000h to 004FFFh
SA3	0	0	0	0	0	0	0	1	1	8/4	006000h to 007FFFh	003000h to 003FFFh
SA2	0	0	0	0	0	0	0	1	0	8/4	004000h to 005FFFh	002000h to 002FFFh
SA1	0	0	0	0	0	0	0	0	1	8/4	002000h to 003FFFh	001000h to 001FFFh
SA0	0	0	0	0	0	0	0	0	0	8/4	000000h to 001FFFh	000000h to 000FFFh

Note : The address range is A_{20} to A_{-1} if in Byte mode ($\overline{\text{BYTE}}$ = V_{IL}) .
　　　　The address range is A_{20} to A_0 if in Word mode ($\overline{\text{BYTE}}$ = V_{IH}) .

Sector Group Address Table (MBM29PL32TM)

Sector Group	A20	A19	A18	A17	A16	A15	A14	A13	A12	Sectors
SGA0	0	0	0	0	X	X	X	X	X	SA0 to SA3
SGA1	0	0	0	1	X	X	X	X	X	SA4 to SA7
SGA2	0	0	1	0	X	X	X	X	X	SA8 to SA11
SGA3	0	0	1	1	X	X	X	X	X	SA12 to SA15
SGA4	0	1	0	0	X	X	X	X	X	SA16 to SA19
SGA5	0	1	0	1	X	X	X	X	X	SA20 to SA23
SGA6	0	1	1	0	X	X	X	X	X	SA24 to SA27
SGA7	0	1	1	1	X	X	X	X	X	SA28 to SA31
SGA8	1	0	0	0	X	X	X	X	X	SA32 to SA35
SGA9	1	0	0	1	X	X	X	X	X	SA36 to SA39
SGA10	1	0	1	0	X	X	X	X	X	SA40 to SA43
SGA11	1	0	1	1	X	X	X	X	X	SA44 to SA47
SGA12	1	1	0	0	X	X	X	X	X	SA48 to SA51
SGA13	1	1	0	1	X	X	X	X	X	SA52 to SA55
SGA14	1	1	1	0	X	X	X	X	X	SA56 to SA59
SGA15	1	1	1	1	0	0	X	X	X	SA60 to SA62
					0	1				
					1	0				
SGA16	1	1	1	1	1	1	0	0	0	SA63
SGA17	1	1	1	1	1	1	0	0	1	SA64
SGA18	1	1	1	1	1	1	0	1	0	SA65
SGA19	1	1	1	1	1	1	0	1	1	SA66
SGA20	1	1	1	1	1	1	1	0	0	SA67
SGA21	1	1	1	1	1	1	1	0	1	SA68
SGA22	1	1	1	1	1	1	1	1	0	SA69
SGA23	1	1	1	1	1	1	1	1	1	SA70

Sector Group Address Table (MBM29PL32BM)

Sector Group	A_{20}	A_{19}	A_{18}	A_{17}	A_{16}	A_{15}	A_{14}	A_{13}	A_{12}	Sectors
SGA0	0	0	0	0	0	0	0	0	0	SA0
SGA1	0	0	0	0	0	0	0	0	1	SA1
SGA2	0	0	0	0	0	0	0	1	0	SA2
SGA3	0	0	0	0	0	0	0	1	1	SA3
SGA4	0	0	0	0	0	0	1	0	0	SA4
SGA5	0	0	0	0	0	0	1	0	1	SA5
SGA6	0	0	0	0	0	0	1	1	0	SA6
SGA7	0	0	0	0	0	0	1	1	1	SA7
SGA8	0	0	0	0	0 / 1 / 1	1 / 0 / 1	X	X	X	SA8 to SA10
SGA9	0	0	0	1	X	X	X	X	X	SA11 to SA14
SGA10	0	0	1	0	X	X	X	X	X	SA15 to SA18
SGA11	0	0	1	1	X	X	X	X	X	SA19 to SA22
SGA12	0	1	0	0	X	X	X	X	X	SA23 to SA26
SGA13	0	1	0	1	X	X	X	X	X	SA27 to SA30
SGA14	0	1	1	0	X	X	X	X	X	SA31 to SA34
SGA15	0	1	1	1	X	X	X	X	X	SA35 to SA38
SGA16	1	0	0	0	X	X	X	X	X	SA39 to SA42
SGA17	1	0	0	1	X	X	X	X	X	SA43 to SA46
SGA18	1	0	1	0	X	X	X	X	X	SA47 to SA50
SGA19	1	0	1	1	X	X	X	X	X	SA51 to SA54
SGA20	1	1	0	0	X	X	X	X	X	SA55 to SA58
SGA21	1	1	0	1	X	X	X	X	X	SA59 to SA62
SGA22	1	1	1	0	X	X	X	X	X	SA63 to SA66
SGA23	1	1	1	1	X	X	X	X	X	SA67 to SA70

Common Flash Memory Interface Code

A_6 to A_0	DQ_{15} to DQ_0	Description
10h 11h 12h	0051h 0052h 0059h	Query-unique ASCII string "QRY"
13h 14h	0002h 0000h	Primary OEM Command Set (02h = Fujitsu standard)
15h 16h	0040h 0000h	Address for Primary Extended Table
17h 18h	0000h 0000h	Alternate OEM Command Set (00h = not applicable)
19h 1Ah	0000h 0000h	Address for Alternate OEM Extended Table (00h = not applicable)
1Bh	0027h	V_{CC} Min (write/erase) DQ_7 to DQ_4: 1 V/bit, DQ_3 to DQ_0: 100 mV/bit
1Ch	0036h	V_{CC} Max (write/erase) DQ_7 to DQ_4: 1 V/bit, DQ_3 to DQ_0: 100 mV/bit
1Dh	0000h	V_{PP} Min voltage (00h = no V_{pp} pin)
1Eh	0000h	V_{PP} Max voltage (00h =no V_{pp} pin)
1Fh	0007h	Typical timeout per single write 2^N μs
20h	0007h	Typical timeout for Min size buffer write 2^N μs
21h	000Ah	Typical timeout per individual sector erase 2^N ms
22h	0000h	Typical timeout for full chip erase 2^N ms
23h	0001h	Max timeout for write 2^N times typical
24h	0005h	Max timeout for buffer write 2^N times typical
25h	0004h	Max timeout per individual sector erase 2^N times typical
26h	0000h	Max timeout for full chip erase 2^N times typical
27h	0016h	Device Size = 2^N byte
28h 29h	0002h 0000h	Flash Device Interface description 02h : $\times 8/ \times 16$
2Ah 2Bh	0005h 0000h	Max number of byte in multi-byte write = 2^N
2Ch	0002h	Number of Erase Block Regions within device (02h = Boot)
2Dh 2Eh 2Fh 30h	0007h 0000h 0020h 0000h	Erase Block Region 1 Information
31h 32h 33h 34h	003Eh 0000h 0000h 0001h	Erase Block Region 2 Information

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A$_6$ to A$_0$	DQ$_{15}$ to DQ$_0$	Description
35h 36h 37h 38h	0000h 0000h 0000h 0000h	Erase Block Region 3 Information
39h 3Ah 3Bh 3Ch	0000h 0000h 0000h 0000h	Erase Block Region 4 Information
40h 41h 42h	0050h 0052h 0049h	Query-unique ASCII string "PRI"
43h	0031h	Major version number, ASCII
44h	0033h	Minor version number, ASCII
45h	0008h	Address Sensitive Unlock Required
46h	0002h	Erase Suspend (02h = To Read & Write)
47h	0004h	Number of sectors in per group
48h	0001h	Sector Temporary Unprotection (01h = Supported)
49h	0004h	Sector Protection Algorithm
4Ah	0000h	Dual Operation (00h = Not Supported)
4Bh	0000h	Burst Mode Type (00h = Not Supported)
4Ch	0001h	Page Mode Type (01h = 4-Word Page Supported)
4Dh	00B5h	V$_{ACC}$ (Acceleration) Supply Minimum DQ$_7$ to DQ$_4$: 1 V/bit, DQ$_3$ to DQ$_0$: 100 mV/bit
4Eh	00C5h	V$_{ACC}$ (Acceleration) Supply Maximum DQ$_7$ to DQ$_4$: 1 V/bit, DQ$_3$ to DQ$_0$: 100 mV/bit
4Fh	00XXh	CFI Write Protect (02h = Bottom Boot Device with WP Protect 03h = Top Boot Device with WP Protect)
50h	01h	Program Suspend (01h = Supported)

Page Mode Read

The device is capable of fast read access for random locations within limited address location called Page. The Page size of the device is 8 bytes / 4 words, within the appropriate Page being selected by the higher address bits A_{20} to A_2 and the address bits A_1 to A_0 in Word mode (A_1 to A_{-1} in Byte mode) determining the specific word within that page. This is an asynchronous operation with the microprocessor supplying the specific word location.

The initial page access is equal to the random access (t_{ACC}) and subsequent Page read access (as long as the locations specified by the microprocessor fall within that Page) is equivalent to the page address access time (t_{PACC}). Here again, $\overline{CE}$ selects the device and $\overline{OE}$ is the output control and should be used to gate data to the output pins if the device is selected. Fast Page mode, accesses are obtained by keeping A_{20} to A_2 constant and changing A_1 and A_0 in Word mode (A_1 to A_{-1} in Byte mode) to select the specific word within that Page.

Output Disable

With the $\overline{OE}$ input at logic high level (V_{IH}), output from the devices are disabled. This may cause the output pins to be in a high impedance state.

Write

Device erasure and programming are accomplished via the command register. The contents of the register serve as inputs to the internal state machine. The state machine outputs dictate the device function.

The command register itself does not occupy any addressable memory location. The register is a latch used to store the commands, along with the address and data information needed to execute the command. The command register is written by bringing $\overline{WE}$ to V_{IL}, while $\overline{CE}$ is at V_{IL} and $\overline{OE}$ is at V_{IH}. Addresses are latched on the falling edge of $\overline{WE}$ or $\overline{CE}$, whichever starts later; while data is latched on the rising edge of $\overline{WE}$ or $\overline{CE}$, whichever starts first. Standard microprocessor write timings are used.

Refer to AC Write Characteristics and the Erase/Programming Waveforms for specific timing parameters.

Sector Group Protection

The device features hardware sector group protection. This feature will disable both program and erase operations in any combination of thirty two sector groups of memory.See "Sector Group Address Table (MBM29PL32TM)" and "Sector Group Address Table (MBM29PL32BM)" in ■DEVICE BUS OPERATION. The user's side can use the sector group protection using programming equipment. The device is shipped with all sector groups that are unprotected.

To activate it, the programming equipment must force V_{ID} on address pin A_9 and control pin $\overline{OE}$, $\overline{CE}$ = V_{IL} and $A_6 = A_3 = A_2 = A_0 = V_{IL}$, $A_1 = V_{IH}$. The sector group addresses (A_{20}, A_{19}, A_{18}, A_{17}, A_{16}, A_{15}, A_{14}, A_{13}, and A_{12}) should be set to the sector to be protected. "Sector Address Table (MBM29PL32TM)" and "Sector Address Table (MBM29PL32BM)" in ■DEVICE BUS OPERATION defines the sector address for each of the seventy-one (71) individual sectors, and "Sector Group Address Table (MBM29PL32TM)" and "Sector Group Address Table (MBM29PL32BM)" in ■DEVICE BUS OPERATION defines the sector group address for each of the twenty-four (24) individual group sectors. Programming of the protection circuitry begins on the falling edge of the $\overline{WE}$ pulse and is terminated with the rising edge of the same. Sector group addresses must be held constant during the $\overline{WE}$ pulse. See "Sector Group Protection Timing Diagram" in ■SWITCHING WAVEFORMS and "Sector Group Protection Algorithm" in ■FLOW CHART for sector group protection timing diagram and algorithm.

To verify programming of the protection circuitry, the programming equipment must force V_{ID} on address pin A_9 with $\overline{CE}$ and $\overline{OE}$ at V_{IL} and $\overline{WE}$ at V_{IH}. Scanning the sector group addresses (A_{20}, A_{19}, A_{18}, A_{17}, A_{16}, A_{15}, A_{14}, A_{13}, and A_{12}) while (A_6, A_3, A_2, A_1, A_0) = (0, 0, 0, 1, 0) will produce a logical "1" code at device output DQ_0 for a protected sector. Otherwise the device will produce "0" for unprotected sectors. In this mode, the lower order addresses, except for A_0, A_1, A_2, A_3, and A_6 can be either High or Low. Address locations with $A_1 = V_{IL}$ are reserved for Autoselect manufacturer and device codes. A_{-1} requires applying to V_{IL} on Byte mode.

It is also possible to determine if a sector group is protected in the system by writing an Autoselect command. Performing a read operation at the address location XX02h, where the higher order addresses(A_{20}, A_{19}, A_{18}, A_{17}, A_{16}, A_{15}, A_{14}, A_{13}, and A_{12}) are the desired sector group address will produce a logical "1" at DQ_0 for a protected sector group. See "Sector Group Protection Verify Autoselect Codes" in ■DEVICE BUS OPERATION for Autoselect codes.

Temporary Sector Group Unprotection

This feature allows temporary unprotection of previously protected sector groups of the devices in order to change data. The Sector Group Unprotection mode is activated by setting the $\overline{\text{RESET}}$ pin to high voltage (V_{ID}). During this mode, formerly protected sector groups can be programmed or erased by selecting the sector group addresses. Once the V_{ID} is taken away from the $\overline{\text{RESET}}$ pin, all the previously protected sector groups will be protected again. Refer to "Temporary Sector Group Unprotection Timing Diagram" in ■SWITCHING WAVE-FORMS and "Temporary Sector Group Unprotection Algorithm" in ■FLOW CHART.

Hardware Reset

The devices may be reset by driving the $\overline{\text{RESET}}$ pin to V_{IL} from V_{IH}. The $\overline{\text{RESET}}$ pin has a pulse requirement and has to be kept low (V_{IL}) for at least "t_{RP}" in order to properly reset the internal state machine. Any operation in the process of being executed will be terminated and the internal state machine will be reset to the read mode "t_{READY}" after the $\overline{\text{RESET}}$ pin is driven low. Furthermore, once the $\overline{\text{RESET}}$ pin goes high, the devices require an additional "t_{RH}" before it will allow read access. When the $\overline{\text{RESET}}$ pin is low, the devices will be in the standby mode for the duration of the pulse and all the data output pins will be tri-stated. If a hardware reset occurs during a program or erase operation, the data at that particular location will be corrupted.

Write Protect ($\overline{\text{WP}}$)

The Write Protection function provides a hardware method of protecting certain outermost 8K bytes / 4K words sectors without using V_{ID}. This function is one of two provided by the $\overline{\text{WP}}$/ACC pin.

If the system asserts V_{IL} on the $\overline{\text{WP}}$/ACC pin, the device disables program and erase functions in the outermost 8K bytes / 4K words sectors independently of whether this sector was protected or unprotected using the method described in "Sector Group Protection" above.

If the system asserts V_{IH} on the $\overline{\text{WP}}$/ACC pin, the device reverts of whether the outermost 8K bytes / 4K words sectors were last set to be protected to the unprotected status. Sector protection or unprotection for this sector depends on whether this was last protected or unprotected using the method described in "Sector protection/unprotection".

Accelerated Program Operation

The device offers accelerated program operation which enables programming in high speed. If the system asserts V_{ACC} to the $\overline{\text{WP}}$/ACC pin, the device automatically enters the acceleration mode and the time required for program operation will reduce to about 85%. This function is primarily intended to allow high speed programing, so caution is needed as the sector group becomes temporarily unprotected.

The system would use a fast program command sequence when programming during acceleration mode. Set command to fast mode and reset command from fast mode are not necessary. When the device enters the acceleration mode, the device is automatically set to fast mode. Therefore, the present sequence could be used for programming and detection of completion during acceleration mode.

Removing V_{ACC} from the $\overline{\text{WP}}$/ACC pin returns the device to normal operation. Do not remove V_{ACC} from the $\overline{\text{WP}}$/ACC pin while programming. See "Accelerated Program Timing Diagram" in ■SWITCHING WAVEFORM.

■ COMMAND DEFINITIONS

Device operations are selected by writing specific address and data sequences into the command register. "MBM29PL32TM/BM Standard Command Definitions" in ■DEVICE BUS OPERATION shows the valid register command sequences. Note that the Erase Suspend (B0h) and Erase Resume (30h) commands are valid only while the Sector Erase operation is in progress. Also the Program Suspend (B0h) and Program Resume (30h) commands are valid only while the Program operation is in progress.Moreover Reset commands are functionally equivalent, resetting the device to the read mode. Please note that commands must be asserted to DQ_7 to DQ_0 and DQ_{15} to DQ_8 bits are ignored.

Reset Command

In order to return from Autoselect mode or Exceeded Timing Limits (DQ_5 = 1) to Read mode, the Reset operation is initiated by writing the Reset command sequence into the command register. The devices remain enabled for reads until the command register contents are altered.

The devices will automatically be in the reset state after power-up. In this case, a command sequence is not required in order to read data.

Autoselect Command

Flash memories are intended for use in applications where the local CPU alters memory contents. Therefore, manufacture and device codes must be accessible while the devices reside in the target system. PROM programmers typically access the signature codes by raising A_9 to a high voltage. However applying high voltage onto the address lines is not generally desired system design practice.

The device contains an Autoselect command operation to supplement traditional PROM programming methodology. The operation is initiated by writing the Autoselect command sequence into the command register.

The Autoselect command sequence is initiated first by writing two unlock cycles. This is followed by a third write cycle that contains the address and the Autoselect command. Then the manufacture and device codes can be read from the address, and an actual data of memory cell can be read from the another address.

Following the command write, a read cycle from address 00h returns the manufactures's code (Fujitsu = 04h). A read cycle at address 01h outputs device code. When 227Eh is output, it indicates that two additional codes, called Extended Device Codes will be required. Therefore the system may continue reading out these Extended Device Codes at address of 0Eh as well as at 0Fh. Notice that above applies to Word mode. The addresses and codes differ from those of Byte mode. Refer to "Sector Group Protection Verify Autoselect Codes" in ■DEVICE BUS OPERATION.

To terminate the operation, it is necessary to write the Reset command into the register. To execute the Autoselect command during the operation, Reset command must be written before the Autoselect command.

Programming

The devices are programmed on a word-by-word basis. Programming is a four bus cycle operation. There are two "unlock" write cycles. These are followed by the program set-up command and data write cycles. Addresses are latched on the falling edge of $\overline{CE}$ or $\overline{WE}$, whichever happens later and the data is latched on the rising edge of $\overline{CE}$ or $\overline{WE}$, whichever happens first. The rising edge of $\overline{CE}$ or $\overline{WE}$ (whichever happens first) starts programming. Upon executing the Embedded Program Algorithm command sequence, the system is not required to provide further controls or timings. The device will automatically provide adequate internally generated program pulses and verify the programmed cell margin.

The system can determine the status of the program operation by using DQ_7 ($\overline{Data}$ Polling), DQ_6 (Toggle Bit) or $RY/\overline{BY}$. The $\overline{Data}$ Polling and Toggle Bit are automatically performed at the memory location being programmed.

The programming operation is completed when the data on DQ_7 is equivalent to data written to this bit at which the devices return to the read mode and plogram addresses are no longer latched. Therefore, the devices require that a valid address to the devices be supplied by the system at this particular instance. Hence $\overline{Data}$ Polling requires the same address which is being programmed.

If hardware reset occurs during the programming operation, the data being written is not guaranteed.

Programming is allowed in any address sequence and across sector boundaries. Beware that a data "0" cannot be programmed back to a "1". Attempting to do so may result in either failure condition or an apparent success according to the data polling algorithm. But a read from Reset mode will show that the data is still "0". Only erase operations can convert "0"s to "1"s.

Note that attempting to program a "1" over a "0" will result in programming failure. This precaution is the same with Fujitsu standard NOR devices. "Embedded Program™ Algorithm" in ■FLOW CHART illustrates the Embedded Program™ Algorithm using typical command strings and bus operations.

Program Suspend/Resume

The Program Suspend command allows the system to interrupt a program operation so that data can be read from any address. Writing the Program Suspend command (B0h) during Embedded Program operation immediately suspends the programming.

When the Program Suspend command is written during a programming process, the device halts the program operation within 1us and updates the status bits.After the program operation has been suspended, the system can read data from any address. The data at program-suspended address is not valid. Normal read timing and command definitions apply.

After the Program Resume command (30h) is written, the device reverts to programming. The system can determine the status of the program operation using the DQ7 or DQ6 status bits, just as in the standard program operation. See "Write Operation Status" for more information.

When issuing program suspend command in 4 μs after issuing program command, determine the status of program operation by reading status bit at more 4 μs after issuing program resume command.

The system also writes the Autoselect command sequence in the Program Suspend mode. The device allows reading Autoselect codes at the addresses within programming sectors, since the codes are not stored in the memory. When the device exits the Autoselect mode, the device reverts to the Program Suspend mode, and is ready for another valid operation. See "Autoselect Command Sequence" for more information.

The system must write the Program Resume command to exit from the Program Suspend mode and continue the programming operation. Further writes of the Resume command are ignored. Another Program Suspend command can be written after the device resumes programming.

Do not read CFI code after HiddenROM Entry and Exit in program suspend mode.

Write Buffer Programming Operations

Write Buffer Programming allows the system write to series of 16 words in one programming operation. This results in faster effective word programming time than the standard programming algorithms. The Write Buffer Programming command sequence is initiated by first writing two unlock cycles. This is followed by a third write cycle selecting the Sector Address in which programming will occur. In forth cycle contains both Sector Address and unique code for data bus width will be loaded into the page buffer at the Sector Address in which programming will occur.

The system then writes the starting address/data combination. This "starting address" must be the same Sector Address used in third and fourth cycles and its lower addresses of A_3 to A_0 should be 0h. All subsequent address must be incremented by 1. Addresses are latched on the falling edge of $\overline{CE}$ or $\overline{WE}$, whichever happens later and the data is latched on the rising edge of $\overline{CE}$ or $\overline{WE}$, whichever happens first. The rising edge of $\overline{CE}$ or $\overline{WE}$ (whichever happens first) starts programming. Upon executing the Write Buffer Programming Operations command sequence, the system is not required to provide further controls or timings. The device will automatically provide adequate internally generated program pulses and verify the programmed cell margin.

DQ_7($\overline{Data}$ Polling), DQ_6(Toggle Bit), DQ_5(Exceeded Timing Limits), DQ_1(Write-to-Buffer Abort) should be monitored to determine the device status during Write Buffer Programming. In addition to these functions, it is also possible to indicate to the host system that Write Buffer Programming Operations are either in progress or have been completed by RY/$\overline{BY}$. See "Hardware Sequence Flags".

The $\overline{Data}$ polling techniques described in "$\overline{Data}$ Polling Algorithm" in ■FLOW CHART should be used while monitoring the last address location loaded into the write buffer. In addition, it is not neccessary to specify an

address in Toggle Bit techniques described in "Toggle Bit Algorithm" in ■FLOW CHART. The automatic pro-graming operation is completed when the data on DQ7 is equivalent to the data written to this bit at which time the device returns to the read mode and addresses are no longer latched (See "Hardware Sequence Flags").

The write-buffer programming operation can be suspended using the standard program suspend/resume com-mands.

Once the write buffer programming is set, the system must then write the "Program Buffer to Flash" command at the Sector Address. Any other address/data combination will abort the Write Buffer Programming operation and the device will continue busy state.

The Write Buffer Programming Sequence can be ABORTED by doing the following :
• Different Sector Address is asserted.
• Write data other than the "Program Buffer to Flash" command after the specified number of "data load" cycles.

A "Write-to-Buffer-Abort Reset" command sequence must be written to the device to return to read mode. (See "MBM29PL32TM/BM Standard Command Definitions" in ■DEVICE BUS OPERATION for details on this com-mand sequence.)

Chip Erase

Chip erase is a six bus cycle operation. It begins two "unlock" write cycles followed by writing the "set-up" command, and two "unlock" write cycles followed by the chip erase command which invokes the Embedded Erase algorithm.

The device does not require the user to program the device prior to erase. Upon executing the Embedded Erase Algorithm the devices automatically programs and verifies the entire memory for an all zero data pattern prior to electrical erase (Preprogram function). The system is not required to provide any controls or timings during these operations.

The system can determine the erase operation status by using DQ7 ($\overline{\text{Data}}$ Polling), DQ6 (Toggle Bit I) and DQ2 (Toggle Bit II) or RY/$\overline{\text{BY}}$ output signal. The chip erase begins on the rising edge of the last $\overline{\text{CE}}$ or $\overline{\text{WE}}$, whichever happens first from last command sequence and completes when the data on DQ7 is "1" (See Write Operation Status section.) at which time the device returns to read mode.

Sector Erase

Sector erase is a six bus cycle operation. There are two "unlock" write cycles. These are followed by writing the "set-up" command. Two more "unlock" write cycles are then followed by the Sector Erase command.

Multiple sectors may be erased concurrently by writing the same six bus cycle operations. This sequence is followed by writes of the Sector Erase command to addresses in other sectors desired to be concurrently erased. The time between writes must be less than Erase Time-out time(t$_{TOW}$). Otherwise that command will not be accepted and erasure will not start. It is recommended that processor interrupts be disabled during this time to guarantee this condition. The interrupts can reoccur after the last Sector Erase command is written. A time-out of "t$_{TOW}$" from the rising edge of last $\overline{\text{CE}}$ or $\overline{\text{WE}}$, whichever happens first, will initiate the execution of the Sector Erase command(s). If another falling edge of $\overline{\text{CE}}$ or $\overline{\text{WE}}$, whichever happens first occurs within the "t$_{TOW}$" time-out window the timer is reset (monitor DQ3 to determine if the sector erase timer window is still open, see section DQ3, Sector Erase Timer). Resetting the devices once execution has begun will corrupt the data in the sector. In that case, restart the erase on those sectors and allow them to complete (refer to the Write Operation Status). Loading the sector erase buffer may be done in any sequence and with any number of sectors (0 to 70).

Sector erase does not require the user to program the devices prior to erase. The devices automatically program all memory locations in the sector(s) to be erased prior to electrical erase using the Embedded Erase Algorithm. When erasing a sector, the remaining unselected sectors remain unaffected. The system is not required to provide any controls or timings during these operations.

The system can determine the status of the erase operation by using DQ7 ($\overline{\text{Data}}$ Polling), DQ6 (Toggle Bit) or RY/$\overline{\text{BY}}$.

The sector erase begins after the "t$_{TOW}$" time-out from the rising edge of $\overline{\text{CE}}$ or $\overline{\text{WE}}$ whichever happens first for the last sector erase command pulse and completes when the data on DQ7 is "1" (see Write Operation Status section), at which the devices return to the read mode. $\overline{\text{Data}}$ polling and Toggle Bit must be performed at an address within any of the sectors being erased.

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Erase Suspend/Resume

The Erase Suspend command allows the user to interrupt Sector Erase operation and then perform read or programming to a sector not being erased. This command is applicable ONLY during the Sector Erase operation within the time-out period for sector erase. Writting the Erase Suspend command (B0h) during the Sector Erase time-out results in immediate termination of the time-out period and suspension of the erase operation.

Writing the "Erase Resume" command (30h) resumes the erase operation.

When the "Erase Suspend" command is written during the Sector Erase operation, the device takes maximum of "t_{SPD}" to suspend the erase operation. When the devices enter the erase-suspended mode, the RY/$\overline{BY}$ output pin will be at High-Z and the DQ_7 bit will be at logic "1" and DQ_6 will stop toggling. The user must use the address of the erasing sector for reading DQ_6 and DQ_7 to determine if the erase operation has been suspended. Further writes of the Erase Suspend command are ignored.

To resume the operation of Sector Erase, the Resume command (30h) should be written. Any further writes of the Resume command at this point will be ignored. Another Erase Suspend command can be written after the chip has resumed erasing.

Do not issue program command after entering erase-suspend-read mode.

Fast Mode Set/Reset

The device has Fast Mode function. It dispenses with the initial two unclock cycles required in the standard program command sequence by writing Fast Mode command into the command register. In this mode, the required bus cycle for programming consists of two cycles instead of four bus cycles in standard program command. The read operation is also executed after exiting this mode. During the Fast mode, do not write any command other than the Fast program/Fast mode reset command. To exit from this mode, write Fast Mode Reset command into the command register. (Refer to the "Embedded Program^{TM} Algorithm for Fast Mode" in ■FLOW CHART.) The V_{CC} active current is required even $\overline{CE}$ = V_{IH} during Fast Mode.

Fast Programming

During Fast Mode, the programming can be executed with two bus cycles operation. The Embedded Program Algorithm is executed by writing program set-up command (A0h) and data write cycles (PA/PD). See "Embedded Program^{TM} Algorithm for Fast Mode" in ■FLOW CHART.

Extended Sector Group Protection

In addition to normal sector group protection, the device has Extended Sector Group Protection as extended function. This function enables protection of the sector group by forcing V_{ID} on $\overline{RESET}$ pin and writes a command sequence. Unlike conventional procedures, it is not necessary to force V_{ID} and control timing for control pins. The only $\overline{RESET}$ pin requires V_{ID} for sector group protection in this mode. The extended sector group protection requires V_{ID} on $\overline{RESET}$ pin. With this condition, the operation is initiated by writing the set-up command (60h) into the command register. Then the sector group addresses pins (A_{20}, A_{19}, A_{18}, A_{17}, A_{16}, A_{15}, A_{14}, A_{13} and A_{12}) and (A_6, A_3, A_2, A_1, A_0) = (0, 0, 0, 1, 0) should be set to the sector group to be protected (set V_{IL} for the other addresses pins is recommended), and write extended sector group protection command (60h). A sector group is typically protected in 250 μs. To verify programming of the protection circuitry, the sector group addresses pins (A_{20}, A_{19}, A_{18}, A_{17}, A_{16}, A_{15}, A_{14}, A_{13} and A_{12}) and (A_6, A_3, A_2, A_1, A_0) = (0, 0, 0, 1, 0) should be set and write a command (40h). Following the command write, a logical "1" at device output DQ_0 will produce for protected sector in the read operation. If the output data is logical "0", write the extended sector group protection command (60h) again. To terminate the operation, set $\overline{RESET}$ pin to V_{IH}. (Refer to the "Extended Sector Group Protection Timing Diagram" in ■SWITCHING WAVEFORMS and "Extended Sector Group Protection Algorithm" in ■FLOW CHART.)

Query Command (CFI : Common Flash Memory Interface)

The CFI (Common Flash Memory Interface) specification outlines device and host system software interrogation handshake which allows specific vendor-specified software algorithms to be used for entire families of devices. This allows device-independent, JEDEC ID-independent, and forward-and backward-compatible software support for the specified flash device families. Refer to CFI specification in detail.

The operation is initiated by writing the query command (98h) into the command register. Following the command write, a read cycle from specific address retrieves device information. Please note that output data of upper byte (DQ_{15} to DQ_8) is "0". Refer to the CFI code table. To terminate operation, it is necessary to write the Reset command sequence into the register. (See "Common Flash Memory Interface Code" in ■DEVICE BUS OPERATION.)

HiddenROM Mode

(1) HiddenROM Region

The HiddenROM (HiddenROM) feature provides a Flash memory region that the system may access through a new command sequence. This is primarily intended for customers who wish to use an Electronic Serial Number (ESN) in the device with the ESN protected against modification. Once the HiddenROM region is protected, any further modification of that region is impossible. This ensures the security of the ESN once the product is shipped to the field.

The HiddenROM region is 256 bytes / 128 words in length. After the system writes the HiddenROM Entry command sequence, it may read the HiddenROM region by using device addresses A_6 to A_0 (A_{20} to A_7 are all "0"). That is, the device sends only program command that would normally be sent to the address to the HiddenROM region. This mode of operation continues until the system issues the Exit HiddenROM command sequence, or until power is removed from the device. On power-up, or following a hardware reset, the device reverts to sending commands to the address.

If you request Fujitsu to program the ESN in the device, please contact a Fujitsu representative for more information.

(2) HiddenROM Entry Command

The device has a HiddenROM area with One Time Protect function. This area is to enter the security code and to unable the change of the code once set. Programming is allowed in this area until it is protected. However, once it gets protected, it is impossible to unprotect. Therefore, extreme caution is required.

The HiddenROM area is 256 bytes / 128 words. This area is in SA0 . Therefore, write the HiddenROM entry command sequence to enter the HiddenROM area. It is called HiddenROM mode when the HiddenROM area appears.

Sectors other than the block area SA0 can be read during HiddenROM mode. Read/program of the HiddenROM area is possible during HiddenROM mode. Write the HiddenROM reset command sequence to exit the HiddenROM mode. Note that any other commands should not be issued than the HiddenROM program/protection/reset commands during the HiddenROM mode. When you issue the other commands including the suspend resume capability, send the HiddenROM reset command first to exit the HiddenROM mode and then issue each command.

(3) HiddenROM Program Command

To program the data to the HiddenROM area, write the HiddenROM program command sequence during HiddenROM mode. This command is the same as the usual program command, except that it needs to write the command during HiddenROM mode. Therefore the detection of completion method is the same as in the past, using the DQ_7 data pooling, DQ_6 Toggle bit or RY/$\overline{BY}$. You should pay attention to the address to be programmed. If an address not in the HiddenROM area is selected, the previous data will be deleted.
During the write into the HiddenROM region, the program suspend command issuance is prohibited.

(4) HiddenROM Protect Command

There are two methods to protect the HiddenROM area. One is to write the sector group protect setup command (60h) , set the sector address in the HiddenROM area and $(A_6, A_3, A_2, A_1, A_0) = (0, 0, 0, 1, 0)$, and write the sector group protect command (60h) during the HiddenROM mode. The same command sequence may be used because it is the same as the extension sector group protect in the past, except that it is in the HiddenROM mode and does not apply high voltage to the $\overline{RESET}$ pin. Please refer to above mentioned "Extended Sector Group Protection" for details of sector group protect setting.
The other method is to apply high voltage (V_{ID}) to A_9 and $\overline{OE}$, set the sector address in the HiddenROM area and $(A_6, A_3, A_2, A_1, A_0) = (0, 0, 0, 1, 0)$, and apply the write pulse during the HiddenROM mode. To verify the protect circuit, apply high voltage (V_{ID}) to A_9, specify $(A_6, A_3, A_2, A_1, A_0) = (0, 0, 0, 1, 0)$ and the sector address in the HiddenROM area, and read. When "1" appears on DQ_0, the protect setting is completed. "0" will appear on DQ_0 if it is not protected. Apply write pulse again. The same command sequence could be used for the above method because other than the HiddenROM mode, it is the same as the sector group protect previously mentioned.

Take note that other sector groups will be affected if an address other than those for the HiddenROM area is selected for the sector group address, so please be careful. Pay close attention that once it is protected, protection CANNOT BE CANCELLED.

Write Operation Status

Detailed in "Hardware Sequence Flags" are all the status flags which can determine the status of the device for current mode operation. When checking Hardware Sequence Flags during program operations, it should be checked 4 μs after issuing program command. During sector erase, the part provides the status flags automatically to the I/O ports. The information on DQ$_2$ is address sensitive. If an address from an erasing sector is consecutively read, then the DQ$_2$ bit will toggle. However DQ$_2$ will not toggle if an address from a non-erasing sector is consecutively read. This allows the user to determine which sectors are erasing.

Once erase suspend is entered address sensitivity still applies. If the address of a non-erasing sector (one available for read) is provided, then stored data can be read from the device. If the address of an erasing sector (one unavailable for read) is applied, the device will output its status bits.

Hardware Sequence Flags

Status			DQ$_7$	DQ$_6$	DQ$_5$	DQ$_3$	DQ$_2$	DQ$_1$*3
In Progress	Embedded Program Algorithm		$\overline{DQ_7}$	Toggle	0	0	1	0
	Embedded Erase Algorithm		0	Toggle	0	1	Toggle*1	N/A
	Program Suspend Mode	Program-Suspend-Read (Program Suspended Sector)	Data	Data	Data	Data	Data	Data
		Program-Suspend-Read (Non-Program Suspended Sector)	Data	Data	Data	Data	Data	Data
	Erase Suspend Mode	Erase-Suspend-Read (Erase Suspended Sector)	1	1	0	0	Toggle*1	N/A
		Erase-Suspend-Read (Non-Erase Suspended Sector)	Data	Data	Data	Data	Data	Data
		Erase-Suspend-Program (Non-Erase Suspended Sector)	$\overline{DQ_7}$	Toggle	0	0	1*2	N/A
Exceeded Time Limits	Embedded Program Algorithm		$\overline{DQ_7}$	Toggle	1	0	1	N/A
	Embedded Erase Algorithm		0	Toggle	1	1	N/A	N/A
	Erase Suspend Mode	Erase-Suspend-Program (Non-Erase Suspended Sector)	$\overline{DQ_7}$	Toggle	1	0	N/A	N/A
Write to Buffer*4	BUSY State		$\overline{DQ_7}$	Toggle	0	N/A	N/A	0
	Exceeded Timing Limits		$\overline{DQ_7}$	Toggle	1	N/A	N/A	0
	ABORT State		N/A	Toggle	0	N/A	N/A	1

*1 : Successive reads from the erasing or erase-suspend sector will cause DQ$_2$ to toggle.

*2 : Reading from non-erase suspend sector address will indicate logic "1" at the DQ$_2$ bit.

*3 : DQ$_1$ indicates the Write-to-Buffer ABORT status during Write-Buffer-Programming operations.

*4 : The $\overline{Data}$ Polling algorithm detailed in "$\overline{Data}$ Polling Algorithm" in ■FLOW CHART should be used for Write-Buffer-Programming operations. Note that $\overline{DQ_7}$ during Write-Buffer-Programming indicates the data-bar for DQ$_7$ data for the LAST LOADED WRITE-BUFFER ADDRESS location.

DQ₇

$\overline{\text{Data}}$ Polling

The devices feature $\overline{\text{Data}}$ Polling as a method to indicate to the host that the Embedded Algorithms are in progress or completed. During the Embedded Program Algorithm, an attempt to read devices will produce reverse data last written to DQ₇. Upon completion of the Embedded Program Algorithm, an attempt to read the device will produce true data last written to DQ₇. During the Embedded Erase Algorithm, an attempt to read the device will produce a "0" at the DQ₇ output. Upon completion of the Embedded Erase Algorithm, an attempt to read device will produce a "1" at the DQ₇ output. The flowchart for $\overline{\text{Data}}$ Polling (DQ₇) is shown in "$\overline{\text{Data}}$ Polling Algorithm" in ■FLOW CHART.

For programming, the $\overline{\text{Data}}$ Polling is valid after the rising edge of fourth write pulse in the four write pulse sequence.

For chip erase and sector erase, the $\overline{\text{Data}}$ Polling is valid after the rising edge of the sixth write pulse in the six write pulse sequence. $\overline{\text{Data}}$ Polling must be performed at sector addresses of sectors being erased, not protected sectors. Otherwise, the status may become invalid.

If a program address falls within a protected sector, Data polling on DQ7 is active for approximately 1 μs, then the device returns to read mode. After an erase command sequence is written, if all sectors selected for erasing are protected, $\overline{\text{Data}}$ Polling on DQ₇ is active for approximately 100 μs, then the device returns to read mode. If not all selected sectors are protected, the Embedded Erase algorithm erases the unprotected sectors, and ignores the selected sectors that are protected.

Once the Embedded Algorithm operation is close to being completed, the device data pins (DQ₇) may change asynchronously while the output enable ($\overline{\text{OE}}$) is asserted low. This means that the device is driving status information on DQ₇ at one instant of time, and then that byte's valid data the next. Depending on when the system samples the DQ₇ output, it may read the status or valid data. Even if the device completes the Embedded Algorithm operation and DQ₇ has a valid data, the data outputs on DQ₆ to DQ₀ may still be invalid. The valid data on DQ₇ to DQ₀ will be read on the successive read attempts.

The $\overline{\text{Data}}$ Polling feature is active only during the Embedded Programming Algorithm, Embedded Erase Algorithm, Erace Suspendmode or sector erase time-out.

See "$\overline{\text{Data}}$ Polling during Embedded Algorithm Operation Timing Diagram" in ■SWITCHING WAVEFORM for the $\overline{\text{Data}}$ Polling timing specifications and diagram.

DQ₆

Toggle Bit I

The device also feature the "Toggle Bit I" as a method to indicate to the host system that the Embedded Algorithms are in progress or completed.

During an Embedded Program or Erase Algorithm cycle, successive attempts to read ($\overline{\text{CE}}$ or $\overline{\text{OE}}$ toggling) data from the devices will result in DQ₆ toggling between one and zero. Once the Embedded Program or Erase Algorithm cycle is completed, DQ₆ will stop toggling and valid data will be read on the next successive attempts. During programming, the Toggle Bit I is valid after the rising edge of the fourth write pulse in the four write pulse sequences. For chip erase and sector erase, the Toggle Bit I is valid after the rising edge of the sixth write pulse in the six write pulse sequences. The Toggle Bit I is active during the sector time out.

In programm operation, if the sector being written to is protected, the Toggle bit will toggle for about 1 μs and then stop toggling with the data unchanged. In erase, the device will erase all the selected sectors except for the protected ones. If all selected sectors are protected, the chip will toggle the Toggle bit for about 100 μs and then drop back into read mode, having data kept remained.

Either $\overline{\text{CE}}$ or $\overline{\text{OE}}$ toggling will cause the DQ₆ to toggle. See " Toggle Bit I Timing Diagramduring Embedded Algorithm Operations" in ■SWITCHING WAVEFORM for the Toggle Bit I timing specifications and diagram.

DQ₅

Exceeded Timing Limits

DQ$_5$ will indicate if the program or erase time has exceeded the specified limits (internal pulse count). Under these conditions DQ$_5$ will produce a "1". This is a failure condition indicating that the program or erase cycle was not successfully completed. $\overline{\text{Data}}$ Polling is the only operating function of the device under this condition. The $\overline{\text{CE}}$ circuit will partially power down the device under these conditions (to approximately 2 mA). The $\overline{\text{OE}}$ and $\overline{\text{WE}}$ pins will control the output disable functions as described in "MBM29PL32TM/BM User Bus Operations (Word Mode : BYTE = VIH)" and "MBM29PL32TM/BM User Bus Operations (Byte Mode : BYTE = VIL)" in ■DEVICE BUS OPERATION.

The DQ$_5$ failure condition may also appear if a user tries to program a non blank location without pre-erase. In this case the device locks out and never completes the Embedded Algorithm operation. Hence, the system never reads a valid data on DQ$_7$ bit and DQ$_6$ never stop toggling. Once the device has exceeded timing limits, the DQ$_5$ bit will indicate a "1". Note that this is not a device failure condition since the device was incorrectly used. If this occurs, reset the device with command sequence.

DQ₃

Sector Erase Timer

After the completion of the initial sector erase command sequence the sector erase time-out will begin. DQ$_3$ will remain low until the time-out is complete. $\overline{\text{Data}}$ Polling and Toggle Bit are valid after the initial sector erase command sequence.

If $\overline{\text{Data}}$ Polling or the Toggle Bit I indicates a valid erase command has been written, DQ$_3$ may be used to determine whether the sector erase timer window is still open. If DQ$_3$ is "1" the internally controlled erase cycle has begun. If DQ$_3$ is "0", the device will accept additional sector erase commands. To insure the command has been accepted, the system software should check the status of DQ$_3$ prior to and following each subsequent Sector Erase command. If DQ$_3$ were high on the second status check, the command may not have been accepted.

See "Hardware Sequence Flags".

DQ₂

Toggle Bit II

This Toggle bit II, along with DQ$_6$, can be used to determine whether the devices are in the Embedded Erase Algorithm or in Erase Suspend.

Successive reads from the erasing sector will cause DQ$_2$ to toggle during the Embedded Erase Algorithm. If the devices are in the erase-suspended-read mode, successive reads from the erase-suspended sector will cause DQ$_2$ to toggle. When the device is in the erase-suspended-program mode, successive reads from the non-erase suspended sector will indicate a logic "1" at the DQ$_2$ bit.

DQ$_6$ is different from DQ$_2$ in that DQ$_6$ toggles only when the standard program or Erase, or Erase Suspend Program operation is in progress. The behavior of these two status bits, along with that of DQ$_7$, is summarized as follows:

For example, DQ$_2$ and DQ$_6$ can be used together to determine if the erase-suspend-read mode is in progress. (DQ$_2$ toggles while DQ$_6$ does not.) See also "Hardware Sequence Flags" and "DQ$_2$ vs. DQ$_6$" in ■SWITCHING WAVEFORM.

Furthermore, DQ$_2$ can also be used to determine which sector is being erased. At the erase mode, DQ$_2$ toggles if this bit is read from an erasing sector.

Reading Toggle Bits DQ$_6$ / DQ$_2$

Whenever the system initially begins reading Toggle bit status, it must read DQ$_7$ to DQ$_0$ at least twice in a row to determine whether a Toggle bit is toggling. Typically a system would note and store the value of the Toggle bit after the first read. After the second read, the system would compare the new value of the Toggle bit with the first. If the Toggle bit is not toggling, the device has completed the program or erase operation. The system can read array data on DQ$_7$ to DQ$_0$ on the following read cycle.

However, if, after the initial two read cycles, the system determines that the Toggle bit is still toggling, the system also should note whether the value of DQ$_5$ is high (see the section on DQ$_5$) . If it is, the system should then determine again whether the Toggle bit is toggling, since the Toggle bit may have stopped toggling just as DQ$_5$ went high. If the Toggle bit is no longer toggling, the device has successfully completed the program or erase operation. If it is still toggling, the device did not complete the operation successfully, and the system must write the reset command to return to reading array data.

The remaining scenario is that the system initially determines that the Toggle bit is toggling and DQ$_5$ has not gone high. The system may continue to monitor the Toggle bit and DQ$_5$ through successive read cycles, determining the status as described in the previous paragraph. Alternatively, it may choose to perform other system tasks. In this case, the system must start at the beginning of the algorithm when it returns to determine the status of the operation. (Refer to "Toggle Bit Algorithm" in ■FLOW CHART.)

Toggle Bit Status

Mode	DQ$_7$	DQ$_6$	DQ$_2$
Program	$\overline{DQ_7}$	Toggle	1
Erase	0	Toggle	Toggle [*1]
Erase-Suspend-Read (Erase-Suspended Sector)	1	1	Toggle [*1]
Erase-Suspend-Program	$\overline{DQ_7}$	Toggle	1 [*2]

*1 : Successive reads from the erasing or erase-suspend sector will cause DQ$_2$ to toggle.

*2 : Reading from the non-erase suspend sector address will indicate logic "1" at the DQ$_2$ bit.

DQ$_1$

Write-to-Buffer Abort

DQ1 indicates whether a Write-to-Buffer operation was aborted. Under these conditions DQ1 produces a "1". The system must issue the Write-to-Buffer-Abort-Reset command sequence to return the device to reading array data. See "Write Buffer Programming Operations" section for more details.

RY/$\overline{BY}$

Ready/Busy

The device provides a RY/$\overline{BY}$ open-drain output pin to indicate to the host system that the Embedded Algorithms are either in progress or has been completed. If the output is low, the device is busy with either a program or erase operation. If the output is high, the device is ready to accept any read/write or erase operation. If the device is placed in an Erase Suspend mode, the RY/$\overline{BY}$ output will be high, by means of connecting with a pull-up resister to V$_{CC}$.

During programming, the RY/$\overline{BY}$ pin is driven low after the rising edge of the fourth $\overline{WE}$ pulse. During an erase operation, the RY/$\overline{BY}$ pin is driven low after the rising edge of the sixth $\overline{WE}$ pulse. The RY/$\overline{BY}$ pin will indicate a busy condition during the $\overline{RESET}$ pulse. See "RY/$\overline{BY}$ Timing Diagram during Program/Erase Operation Timing Diagram" and "RESET Timing Diagram (During Embedded Algorithms)" in ■SWITCHING WAVEFORM for a detailed timing diagram. The RY/$\overline{BY}$ pin is pulled high in standby mode.

Since this is an open-drain output, RY/$\overline{BY}$ pins can be tied together in parallel with a pull-up resistor to V$_{CC}$.

Word/Byte Configuration

$\overline{\text{BYTE}}$ pin selects the byte (8-bit) mode or word (16-bit) mode for the device. When this pin is driven high, the device operates in the word (16-bit) mode. Data is read and programmed at DQ_{15} to DQ_0. When this pin is driven low, the device operates in byte (8-bit) mode. In this mode, DQ_{15}/A_{-1} pin becomes the lowest address bit, and DQ_{14} to DQ_8 bits are tri-stated. However, the command bus cycle is always an 8-bit operation and hence commands are written at DQ_7 to DQ_0 and DQ_{15} to DQ_8 bits are ignored.

Data Protection

The device is designed to offer protection against accidental erasure or programming caused by spurious system level signals that may exist during power transitions. During power up the device automatically reset the internal state machine in Read mode. Also, with its control register architecture, alteration of memory contents only occurs after successful completion of specific multi-bus cycle command sequences.

The device also incorporates several features to prevent inadvertent write cycles resulting form V_{CC} power-up and power-down transitions or system noise.

(1) Low V_{CC} Write Inhibit

To avoid initiation of a write cycle during V_{CC} power-up and power-down, a write cycle is locked out for V_{CC} less than V_{LKO}. If $V_{CC} < V_{LKO}$, the command register is disabled and all internal program/erase circuits are disabled. Under this condition, the device will reset to the read mode. Subsequent writes will be ignored until the V_{CC} level is greater than V_{LKO}. It is the user's responsibility to ensure that the control pins are logically correct to prevent unintentional writes when V_{CC} is above V_{LKO}.

If Embedded Erase Algorithm is interrupted, the intervened erasing sector(s) is(are) not valid.

(2) Write Pulse "Glitch" Protection

Noise pulses of less than 3 ns (typical) on $\overline{\text{OE}}$, $\overline{\text{CE}}$, or $\overline{\text{WE}}$ will not initiate a write cycle.

(3) Logical Inhibit

Writing is inhibited by holding any one of $\overline{\text{OE}} = V_{IL}$, $\overline{\text{CE}} = V_{IH}$, or $\overline{\text{WE}} = V_{IH}$. To initiate a write, $\overline{\text{CE}}$ and $\overline{\text{WE}}$ must be a logical zero while $\overline{\text{OE}}$ is a logical one.

(4) Power-up Write Inhibit

Power-up of the devices with $\overline{\text{WE}} = \overline{\text{CE}} = V_{IL}$ and $\overline{\text{OE}} = V_{IH}$ will not accept commands on the rising edge of $\overline{\text{WE}}$. The internal state machine is automatically reset to read mode on power-up.

(5) Sector Protection

Device user is able to protect each sector group individually to store and protect data. Protection circuit voids both write and erase commands that are addressed to protected sectors.
Any commands to write or erase addressed to protected sector are ignored .

■ ABSOLUTE MAXIMUM RATINGS

Parameter	Symbol	Rating		Unit
		Min	Max	
Storage Temperature	Tstg	−55	+125	°C
Ambient Temperature with Power Applied	T_A	−20	+85	°C
Voltage with Respect to Ground All Pins Except A_9, $\overline{OE}$, and $\overline{RESET}$ [1],[2]	V_{IN}, V_{OUT}	−0.5	V_{CC} +0.5	V
Power Supply Voltage [1]	V_{CC}	−0.5	+4.0	V
Input Voltage A_9, $\overline{OE}$, and $\overline{RESET}$ [1],[3]	V_{IN}	−0.5	+12.5	V
Input Voltage $\overline{WP}$/ACC [1],[3]	V_{ACC}	−0.5	+12.5	V

[1] : Voltage is defined on the basis of VSS = GND = 0 V.

[2] : Minimum DC voltage on input or I/O pins is −0.5 V. During voltage transitions, input or I/O pins may undershoot V_{SS} to −0.2 V for periods of up to 20 ns. Maximum DC voltage on input or I/O pins is V_{CC} +0.5 V. During voltage transitions, input or I/O pins may overshoot to V_{CC} +2.0 V for periods of up to 20 ns

[3] : Minimum DC input voltage is −0.5V. During voltage transitions, these pins may undershoot V_{SS} to −0.2 V for periods of up to 20 ns. Voltage difference between input and supply voltage (V_{IN}–V_{CC}) dose not exceed to +9.0 V. Maximum DC input voltage is +12.5 V which may overshoot to +14.0 V for periods of up to 20 ns .

WARNING: Semiconductor devices can be permanently damaged by application of stress (voltage, current, temperature, etc.) in excess of absolute maximum ratings. Do not exceed these ratings.

■ RECOMMENDED OPERATING CONDITIONS

Parameter		Symbol	Value		Unit
			Min	Max	
Ambient Temperature	90	T_A	−20	+70	°C
	10		−20	+85	
V_{CC} Supply Voltage *		V_{CC}	+3.0	+3.6	V

* : Voltage is defined on the basis of VSS = GND = 0V.

WARNING: The recommended operating conditions are required in order to ensure the normal operation of the semiconductor device. All of the device's electrical characteristics are warranted when the device is operated within these ranges.

No warranty is made with respect to uses, operating conditions, or combinations not represented on the data sheet. Users considering application outside the listed conditions are advised to contact their FUJITSU representatives beforehand.

Always use semiconductor devices within their recommended operating condition ranges. Operation outside these ranges may adversely affect reliability and could result in device failure.

■ **MAXIMUM OVERSHOOT/MAXIMUM UNDERSHOOT**

+0.6 V
−0.5 V
−2.0 V

20 ns   20 ns   20 ns
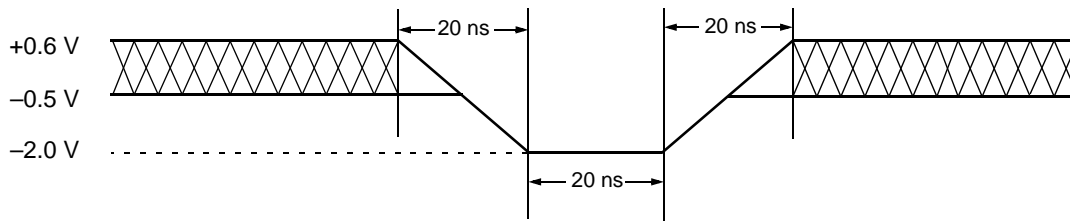
Maximum Undershoot Waveform

V_{CC} +2.0 V
V_{CC} +0.5 V
0.7 × V_{CC}

20 ns   20 ns   20 ns

Maximum Overshoot Waveform 1

+14.0 V
+12.5 V
V_{CC} +0.5 V

20 ns   20 ns   20 ns
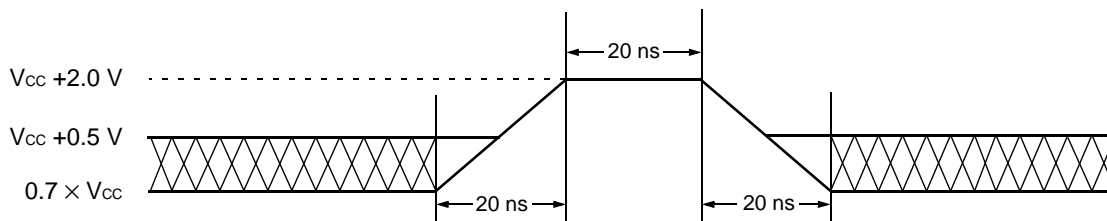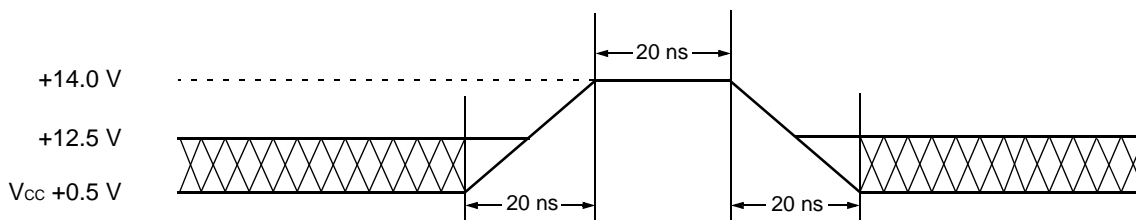
Note: This waveform is applied for A₉, $\overline{OE}$, $\overline{RESET}$, and ACC.

Maximum Overshoot Waveform 2

■ ELECTRICAL CHARACTERISTICS

1. DC Characteristics

Parameter	Symbol	Conditions		Min	Typ	Max	Unit
Input Leakage Current	I_{LI}	$V_{IN} = V_{SS}$ to V_{CC}, $V_{CC} = V_{CC}$ Max	$\overline{WP}$/ACC pin	−2.0	—	+2.0	μA
			Others	−1.0	—	+1.0	
Output Leakage Current	I_{LO}	$V_{OUT} = V_{SS}$ to V_{CC}, $V_{CC} = V_{CC}$ Max		−1.0	—	+1.0	μA
A_9, $\overline{OE}$, $\overline{RESET}$ Inputs Leakage Current	I_{LIT}	$V_{CC} = V_{CC}$ Max, A_9, $\overline{OE}$, $\overline{RESET}$ = 12.5 V		—	—	35	μA
Vcc Active Current (Read) [1],[2]	I_{CC1}	$\overline{CE} = V_{IL}$, $\overline{OE} = V_{IH}$, f = 5 MHz	Word	—	18	20	mA
			Byte	—	16	20	
		$\overline{CE} = V_{IL}$, $\overline{OE} = V_{IH}$, f = 10 MHz	Word	—	35	50	
			Byte	—	35	50	
Vcc Active Current (Intra-Page Read) [2]	I_{CC2}	$\overline{CE} = V_{IL}$, $\overline{OE} = V_{IH}$, t_{PRC} = 25ns, 4-Word		—	10	20	mA
Vcc Active Current (Program / Erase) [2],[3]	I_{CC3}	$\overline{CE} = V_{IL}$, $\overline{OE} = V_{IH}$		—	50	60	mA
Vcc Standby Current [2]	I_{CC4}	$\overline{CE} = V_{CC} \pm 0.3$ V, $\overline{RESET} = V_{CC} \pm 0.3$ V, $\overline{OE} = V_{IH}$, $\overline{WP}$/ACC = $V_{CC} \pm 0.3$ V		—	1	5	μA
Vcc Reset Current [2]	I_{CC5}	$\overline{RESET} = V_{CC} \pm 0.3$ V, $\overline{WP}$/ACC = $V_{CC} \pm 0.3$ V		—	1	5	μA
Vcc Automatic Sleep Current [4]	I_{CC6}	$\overline{CE} = V_{SS} \pm 0.3$ V, $\overline{RESET} = V_{CC} \pm 0.3$ V, $V_{IN} = V_{CC} \pm 0.3$V or $V_{SS} \pm 0.3$V, $\overline{WP}$/ACC = $V_{CC} \pm 0.3$ V		—	1	5	μA
Vcc Active Current (Erase-Suspend-Program) [2]	I_{CC7}	$\overline{CE} = V_{IL}$, $\overline{OE} = V_{IH}$		—	50	60	mA
ACC Accelerated Program Current	I_{ACC}	$\overline{CE} = V_{IL}$, $\overline{OE} = V_{IH}$, Vcc = Vcc Max, $\overline{WP}$/ACC =V_{ACC} Max	$\overline{WP}$/ACC pin	—	—	20	mA
			Vcc Pin	—	—	60	
Input Low Level	V_{IL}	—		−0.5	—	0.6	V
Input High Level	V_{IH}	—		$0.7 \times V_{CC}$	—	$V_{CC} + 0.3$	V
Voltage for $\overline{WP}$/ACC Sector Protection/Unprotection and Program Acceleration	V_{ACC}	V_{CC} = 3.0 V to 3.6 V		11.5	12.0	12.5	V
Voltage for Autoselect, and Temporary Sector Unprotected	V_{ID}	V_{CC} = 3.0 V to 3.6 V		11.5	12.0	12.5	V
Output Low Voltage Level	V_{OL}	I_{OL} = 4.0 mA, $V_{CC} = V_{CC}$ Min		—	—	0.45	V
Output High Voltage Level	V_{OH}	I_{OH} = −2.0 mA, $V_{CC} = V_{CC}$ Min		$0.85 \times V_{CC}$	—	—	V
Low Vcc Lock-Out Voltage	V_{LKO}	—		2.3	—	2.5	V

[1] : The I_{CC} current listed includes both the DC operating current and the frequency dependent component.

[2] : Maximum I_{CC} values are tested with $V_{CC} = V_{CC}$ Max

[3] : I_{CC} active while Embedded Erase or Embedded Program or Write Buffer Programming is in progress.

[4] : Automatic sleep mode enables the low power mode when address remain stable for t_{ACC} + 30 ns.

2. AC Characteristics
   • **Read Only Operations Characteristics**

Parameter	Symbols		Condition	Value*				Unit
				90		10		
	JEDEC	Standard		Min	Max	Min	Max	
Read Cycle Time	t_{AVAV}	t_{RC}	—	90	—	100	—	ns
Address to Output Delay	t_{AVQV}	t_{ACC}	$\overline{CE} = V_{IL,}$ $\overline{OE} = V_{IL}$	—	90	—	100	ns
Chip Enable to Output Delay	t_{ELQV}	t_{CE}	$\overline{OE} = V_{IL}$	—	90	—	100	ns
Page Read Cycle Time	—	t_{PRC}	—	25	—	30	—	ns
Page Address to Output Delay	—	t_{PACC}	$\overline{CE} = V_{IL,}$ $\overline{OE} = V_{IL}$	—	25	—	30	ns
Output Enable to Output Delay	t_{GLQV}	t_{OE}	—	—	25	—	30	ns
Chip Enable to Output High-Z	t_{EHQZ}	t_{DF}	—	—	25	—	30	ns
Output Enable Hold Time — Read	—	t_{OEH}	—	0	—	0	—	ns
Output Enable Hold Time — Toggle and $\overline{Data}$ Polling			—	10	—	10	—	ns
Output Enable to Output High-Z	t_{GHQZ}	t_{DF}	—	—	25	—	30	ns
Output Hold Time From Addresses, $\overline{CE}$ or $\overline{OE}$, Whichever Occurs First	t_{AXQX}	t_{OH}	—	0	—	0	—	ns
$\overline{RESET}$ Pin Low to Read Mode	—	t_{READY}	—	—	20	—	20	µs

* : Test Conditions :
      Output Load   : 1 TTL gate and 30 pF
      Input rise and fall times : 5 ns
      Input pulse levels   : 0.0 V or V_{CC}
      Timing measurement reference level
                  Input   : V_{CC} / 2
                  Output : V_{CC} / 2

Test Conditions
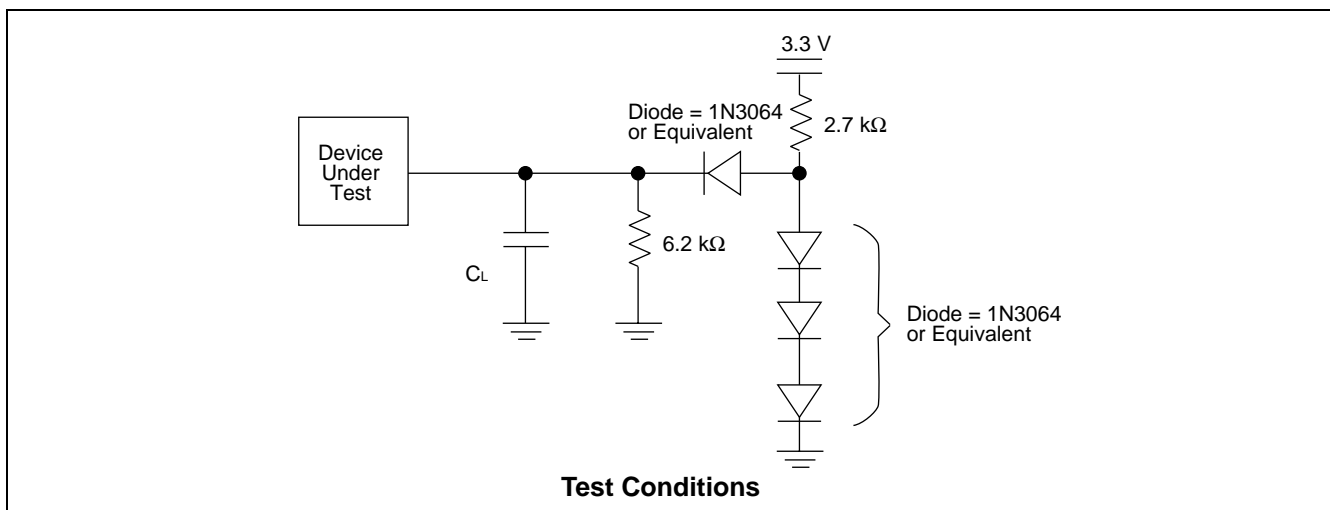
• **Write (Erase/Program) Operations**

Parameter		Symbol		Value						Unit
				90			10			
		JEDEC	Standard	Min	Typ	Max	Min	Typ	Max	
Write Cycle Time		t_{AVAV}	t_{WC}	90	—	—	100	—	—	ns
Address Setup Time		t_{AVWL}	t_{AS}	0	—	—	0	—	—	ns
Address Setup Time to $\overline{OE}$ Low During Toggle Bit Polling		—	t_{ASO}	15	—	—	15	—	—	ns
Address Hold Time		t_{WLAX}	t_{AH}	45	—	—	45	—	—	ns
Address Hold Time from $\overline{CE}$ or $\overline{OE}$ High During Toggle Bit Polling		—	t_{AHT}	0	—	—	0	—	—	ns
Data Setup Time		t_{DVWH}	t_{DS}	35	—	—	35	—	—	ns
Data Hold Time		t_{WHDX}	t_{DH}	0	—	—	0	—	—	ns
$\overline{OE}$ Setup Time		—	t_{OES}	0	—	—	0	—	—	ns
$\overline{CE}$ High During Toggle Bit Polling		—	t_{CEPH}	20	—	—	20	—	—	ns
$\overline{OE}$ High During Toggle Bit Polling		—	t_{OEPH}	20	—	—	20	—	—	ns
Read Recover Time Before Write ($\overline{OE}$ High to $\overline{WE}$ Low)		t_{GHWL}	t_{GHWL}	0	—	—	0	—	—	ns
Read Recover Time Before Write ($\overline{OE}$ High to $\overline{CE}$ Low)		t_{GHEL}	t_{GHEL}	0	—	—	0	—	—	ns
$\overline{CE}$ Setup Time		t_{ELWL}	t_{CS}	0	—	—	0	—	—	ns
$\overline{WE}$ Setup Time		t_{WLEL}	t_{WS}	0	—	—	0			ns
$\overline{CE}$ Hold Time		t_{WHEH}	t_{CH}	0	—	—	0	—	—	ns
$\overline{WE}$ Hold Time		t_{EHWH}	t_{WH}	0	—	—	0	—	—	ns
$\overline{CE}$ Pulse Width		t_{ELEH}	t_{CP}	35	—	—	35	—	—	ns
Write Pulse Width		t_{WLWH}	t_{WP}	35	—	—	35	—	—	ns
$\overline{CE}$ Pulse Width High		t_{EHEL}	t_{CPH}	25	—	—	25	—	—	ns
Write Pulse Width High		t_{WHWL}	t_{WPH}	30	—	—	30	—	—	ns
Effective Page Programming Time (Write Buffer Programming)	Per Word	t_{WHWH1}	t_{WHWH1}	—	23.5	—	—	23.5	—	μs
Programming Time	Word			—	100	—	—	100	—	μs
Sector Erase Operation *1		t_{WHWH2}	t_{WHWH2}	—	1.0	—	—	1.0	—	s
V_{CC} Setup Time		—	t_{VCS}	50	—	—	50	—	—	μs
Recovery Time From RY/$\overline{BY}$		—	t_{PB}	0	—	—	0	—	—	ns
Erase/Program Valid to RY/$\overline{BY}$ Delay		—	t_{BUSY}	—	—	90	—	—	90	ns
Rise Time to V_{ID} *2		—	t_{VIDR}	500	—	—	500	—	—	ns
Rise Time to V_{ACC} *3		—	t_{VACCR}	500	—	—	500	—	—	ns
Voltage Transition Time *2		—	t_{VLHT}	4	—	—	4	—	—	μs

(Continued)

40

(Continued)

Parameter	Symbol		Value						Unit
			90			10			
	JEDEC	Standard	Min	Typ	Max	Min	Typ	Max	
Write Pulse Width *2	—	t_{WPP}	100	—	—	100	—	—	µs
$\overline{OE}$ Setup Time to $\overline{WE}$ Active *2	—	t_{OESP}	4	—	—	4	—	—	µs
$\overline{CE}$ Setup Time to $\overline{WE}$ Active *2	—	t_{CSP}	4	—	—	4	—	—	µs
$\overline{RESET}$ Pulse Width	—	t_{RP}	500	—	—	500	—	—	ns
$\overline{RESET}$ High Time Before Read	—	t_{RH}	100	—	—	100	—	—	ns
Delay Time from Embedded Output Enable	—	t_{EOE}	—	—	90	—	—	100	ns
Erase Time-out Time	—	t_{TOW}	50	—	—	50	—	—	µs
Erase Suspend Transition Time	—	t_{SPD}	—	—	20	—	—	20	µs

*1 : This does not include the preprogramming time.

*2 : This timing is for Sector Group Protection operation.

*3 : This timing is for Accelerated Program operation.

■ ERASE AND PROGRAMMING PERFORMANCE

Parameter	Limits			Unit	Remarks
	Min	Typ	Max		
Sector Erase Time	—	1	15	s	Excludes programming time prior to erasure
Programming Time	—	100	3000	µs	Excludes system-level overhead
Effective Page Programming Time (Write Buffer Programming)	—	23.5	—	µs	
Chip Programming Time	—	—	300	s	
Absolute Maximum Programming Time (16 words)	—	—	6	ms	Non programming within the same page
Erase/Program Cycle	100,000	—	—	cycle	—

■ TSOP (1) PIN CAPACITANCE

Parameter	Symbol	Test Setup	Value			Unit
			Min	Typ	Max	
Input Capacitance	C_{IN}	$V_{IN} = 0$	—	8	10	pF
Output Capacitance	C_{OUT}	$V_{OUT} = 0$	—	8.5	12	pF
Control Pin Capacitance	C_{IN2}	$V_{IN} = 0$	—	8	10	pF
$\overline{RESET}$ pin and $\overline{WP}$/ACC Pin Capacitance	C_{IN3}	$V_{IN} = 0$	—	20	25	pF

Notes : • Test conditions $T_A = +25°C$, f = 1.0 MHz
  • DQ_{15}/A-1 pin capacitance is stipulated by output capacitance.

■ FBGA PIN CAPACITANCE

Parameter	Symbol	Test Setup	Value			Unit
			Min	Typ	Max	
Input Capacitance	C_{IN}	$V_{IN} = 0$	—	8	10	pF
Output Capacitance	C_{OUT}	$V_{OUT} = 0$	—	8.5	12	pF
Control Pin Capacitance	C_{IN2}	$V_{IN} = 0$	—	8	10	pF
$\overline{RESET}$ pin and $\overline{WP}$/ACC Pin Capacitance	C_{IN3}	$V_{IN} = 0$	—	15	20	pF

Notes : • Test conditions $T_A = +25°C$, f = 1.0 MHz
  • DQ_{15}/A-1 pin capacitance is stipulated by output capacitance.

■ **SWITCHING WAVEFORMS**
 • **Key to Switching Waveforms**

WAVEFORM	INPUTS	OUTPUTS
	Must Be Steady	Will Be Steady
	May Change from H to L	Will Be Changing from H to L
	May Change from L to H	Will Be Changing from L to H
	"H" or "L" Any Change Permitted	Changing State Unknown
	Does Not Apply	Center Line is High-Impedance "Off" State

Read Operation Timing Diagram

43
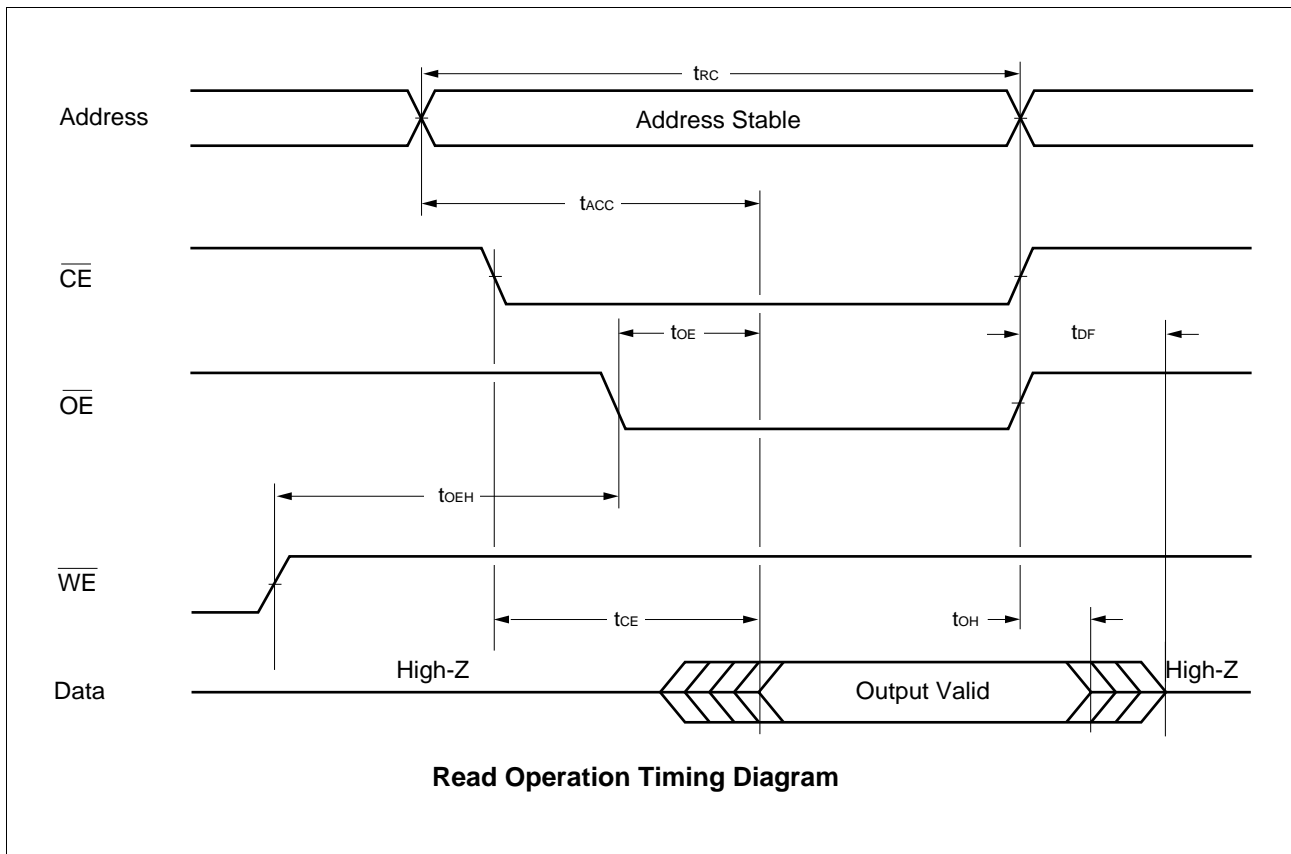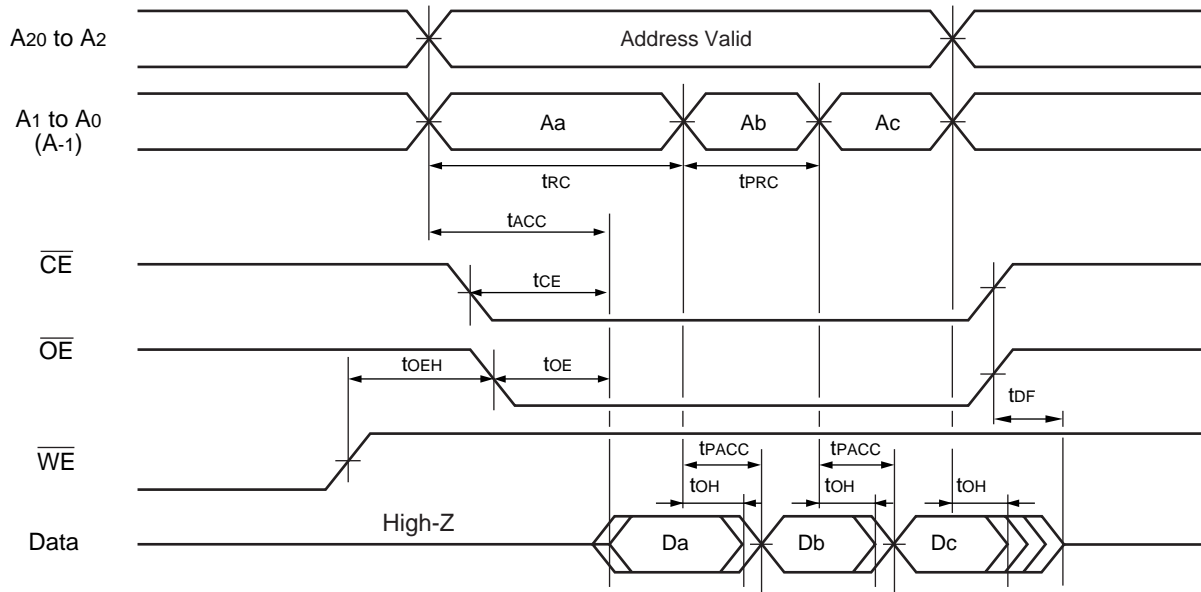
Page Read Operation Timing Diagram
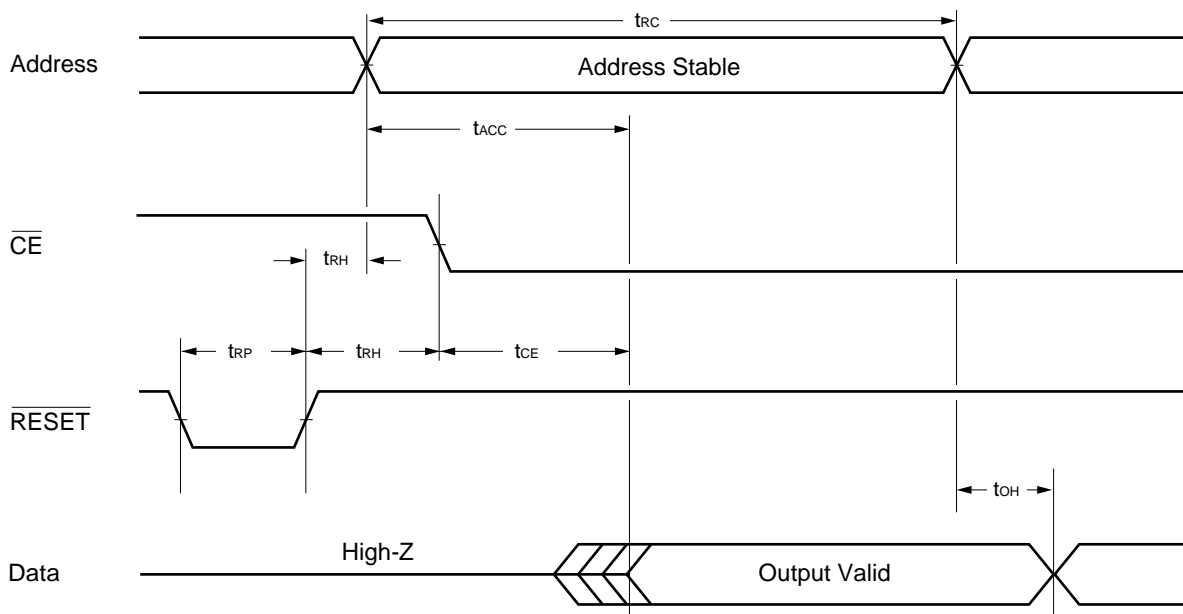
Hardware Reset/Read Operation Timing Diagram
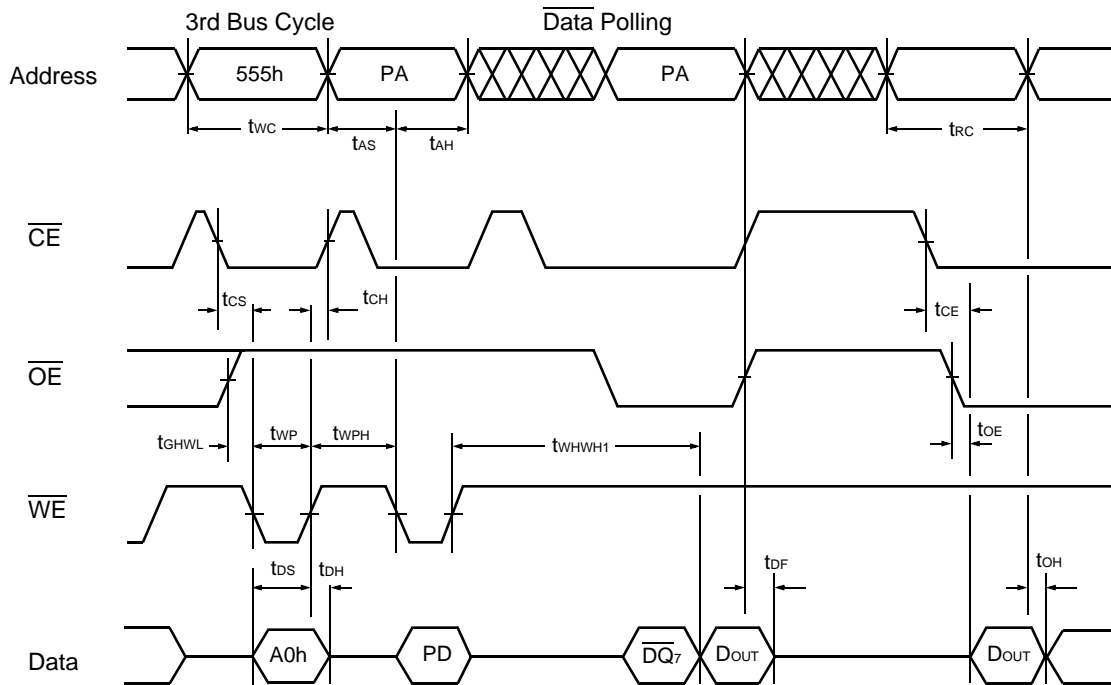
3rd Bus Cycle $\overline{\text{Data}}$ Polling

Address 555h PA PA

t_{WC} t_{AS} t_{AH} t_{RC}

$\overline{\text{CE}}$

t_{CS} t_{CH} t_{CE}

$\overline{\text{OE}}$

t_{GHWL} t_{WP} t_{WPH} t_{WHWH1} t_{OE}

$\overline{\text{WE}}$

t_{DS} t_{DH} t_{DF} t_{OH}

Data A0h PD $\overline{\text{DQ}_7}$ D_{OUT} D_{OUT}

Notes : • PA is address of the memory location to be programmed.
• PD is data to be programmed at word address.
• $\overline{\text{DQ}_7}$ is the output of the complement of the data written to the device.
• D_{OUT} is the output of the data written to the device.
• Figure indicates the last two bus cycles out of four bus cycle sequence.

Alternate $\overline{\text{WE}}$ Controlled Program Operation Timing Diagram
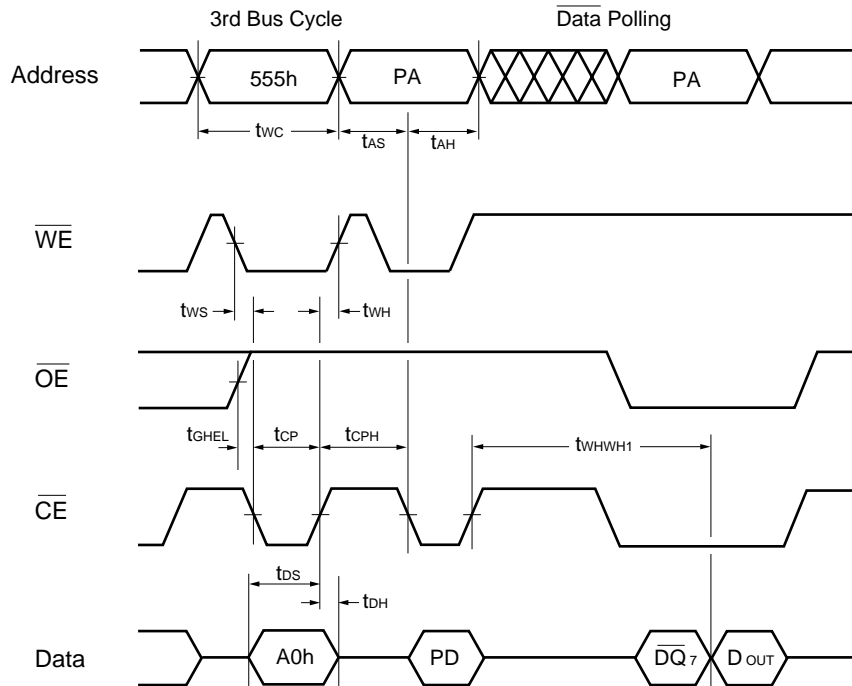
Notes : • PA is address of the memory location to be programmed.
   • PD is data to be programmed at word address.
   • DQ7 is the output of the complement of the data written to the device.
   • DOUT is the output of the data written to the device.
   • Figure indicates the last two bus cycles out of four bus cycle sequence.

Alternate CE Controlled Program Operation Timing Diagram
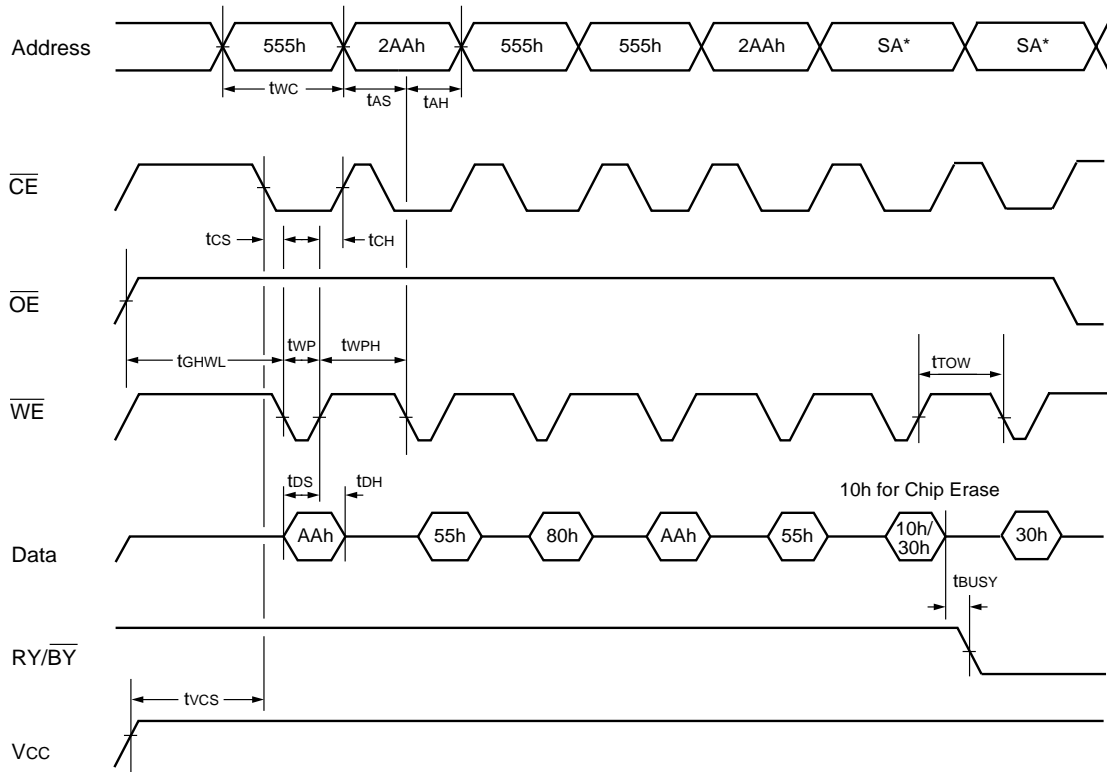
* : SA is the sector address for Sector Erase. Address = 555h (Word), AAAh (Byte) for Chip Erase.

Chip/Sector Erase Operation Timing Diagram
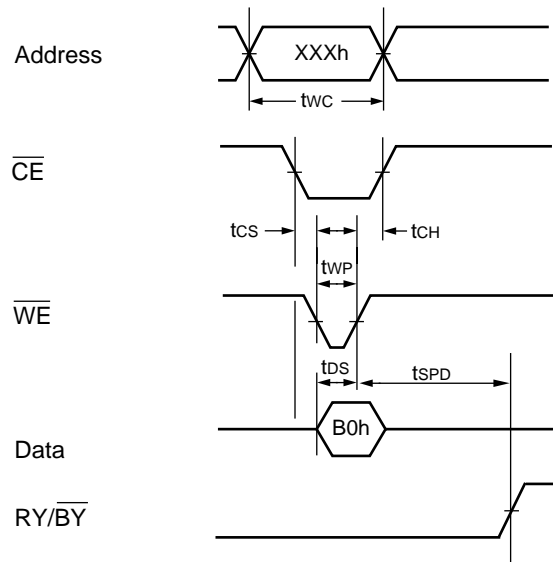
Erase Suspend Operation Timing Diagram
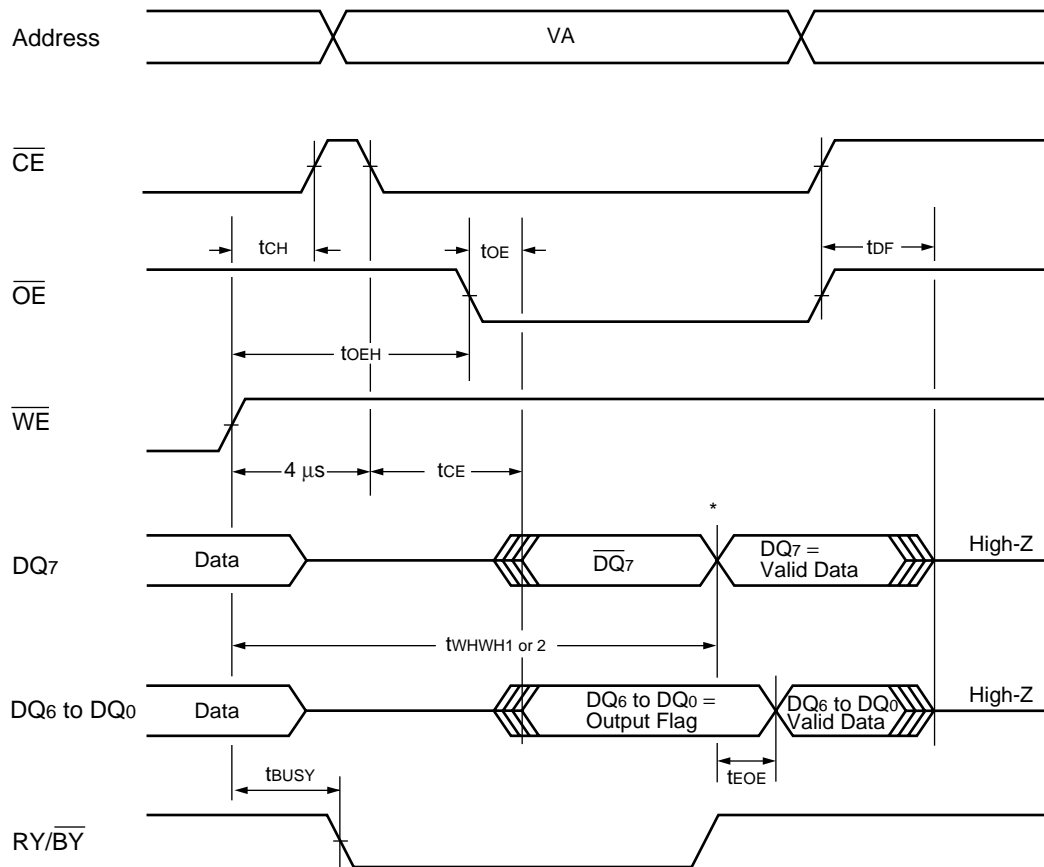
* : DQ$_7$ = Valid Data (The device has completed the Embedded operation.)

Note : When checking Hardware Sequence Flags during program operations, it should be checked 4 μs after issuing program command.

Data Polling during Embedded Algorithm Operation Timing Diagram

Address

t_{AHT} t_{ASO} t_{AHT} t_{AS}

$\overline{CE}$

t_{CEPH}

$\overline{WE}$

t_{OEPH}

4 μs t_{OEH}

$\overline{OE}$

t_{DH} t_{OE} t_{CE}

DQ6/DQ2   Data   Toggle Data   Toggle Data   Toggle Data   * Stop Toggling   Output Valid

t_{BUSY}

RY/$\overline{BY}$
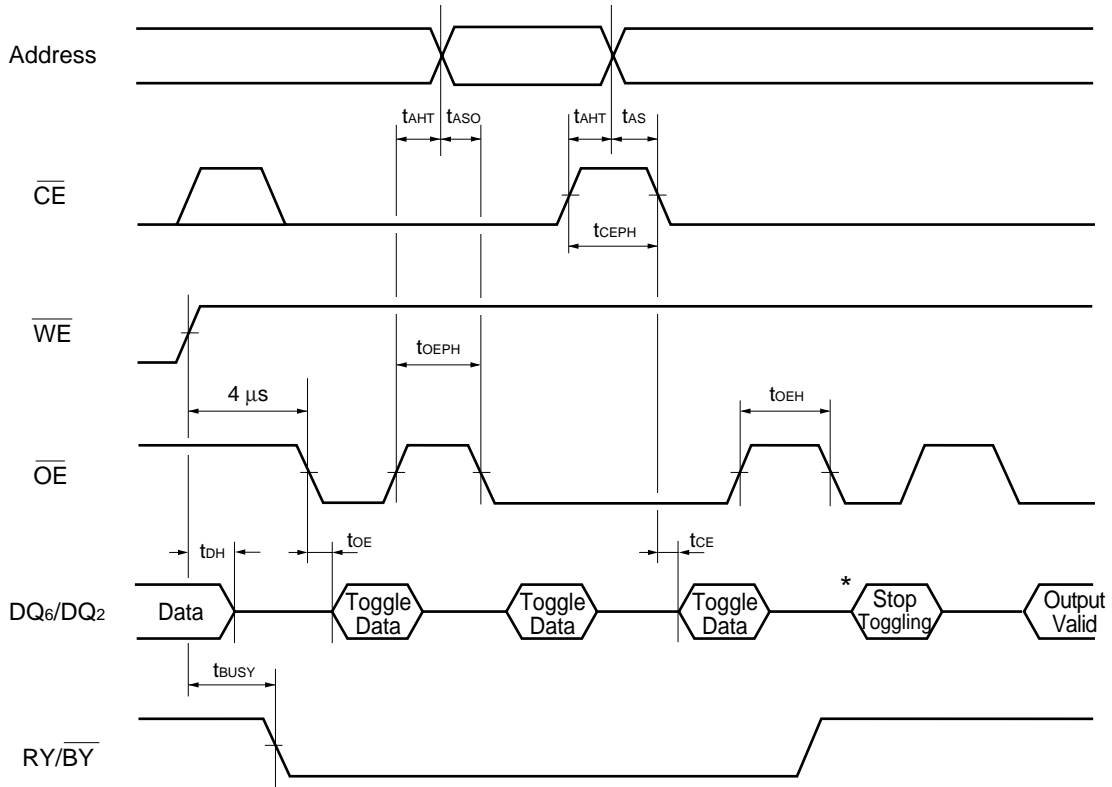
* : DQ6 stops toggling (The device has completed the Embedded operation).

Note : When checking Hardware Sequence Flags during program operations, it should be checked 4 μs after issuing program command.

Toggle Bit I Timing Diagram during Embedded Algorithm Operations

Enter Embedded Erasing   Erase Suspend   Enter Erase Suspend Program   Erase Resume

$\overline{WE}$ Erase   Erase Suspend Read   Erase Suspend Program   Erase Suspend Read   Erase   Erase Complete

DQ6

DQ2*

Toggle DQ2 and DQ6 with $\overline{OE}$ or $\overline{CE}$
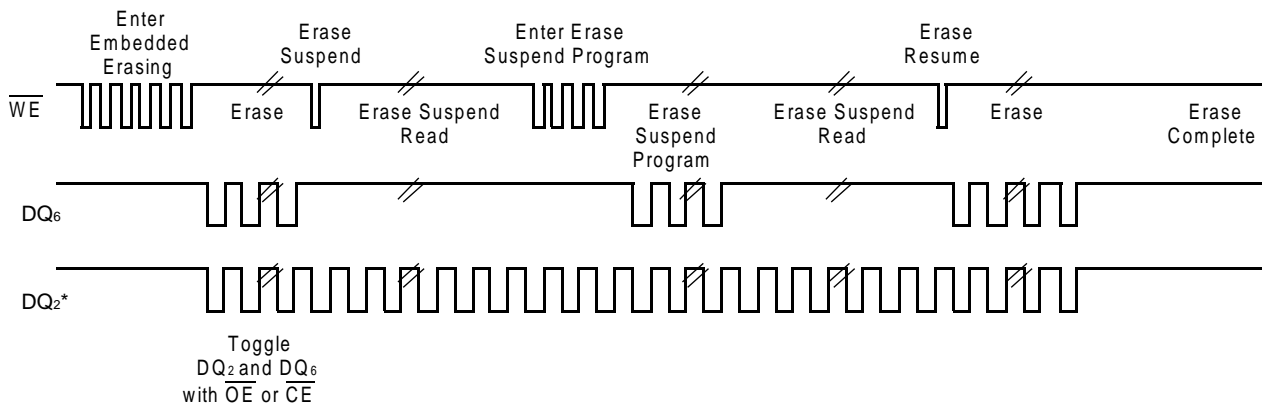
* : DQ2 is read from the erase-suspended sector.

DQ2 vs. DQ6

$\overline{\text{CE}}$

Rising edge of the last $\overline{\text{WE}}$ signal

$\overline{\text{WE}}$

Entire programming
or erase operations

RY/$\overline{\text{BY}}$

t_{BUSY}

RY/$\overline{\text{BY}}$ Timing Diagram during Program/Erase Operation Timing Diagram

$\overline{\text{CE}}$, $\overline{\text{OE}}$

t_{RH}

$\overline{\text{RESET}}$

t_{RP}

t_{READY}
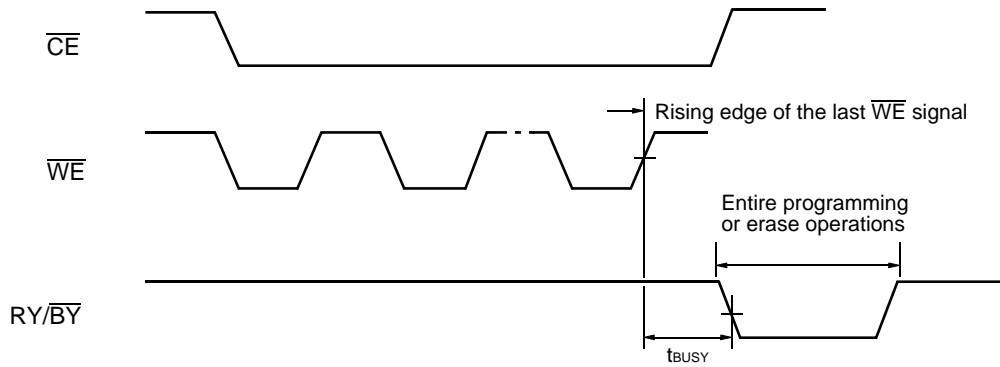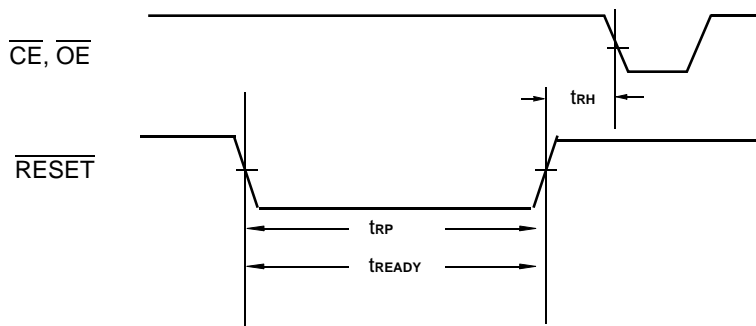
$\overline{\text{RESET}}$ Timing Diagram (Not during Embedded Algorithms)
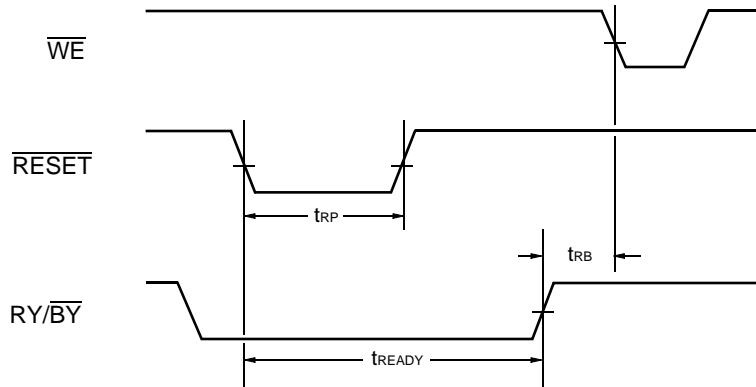
RESET Timing Diagram (During Embedded Algorithms)
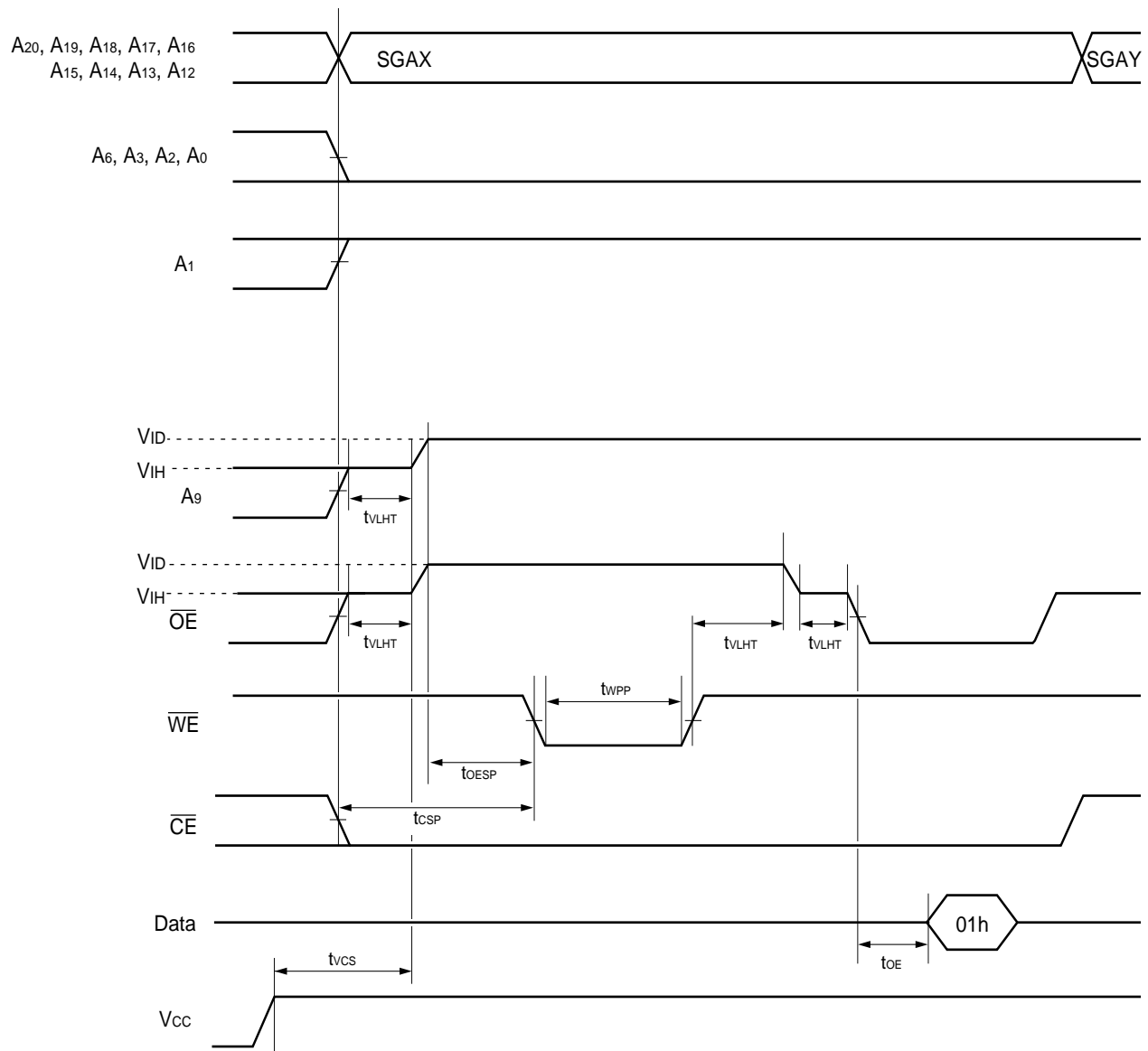
SGAX : Sector Group Address to be protected
SGAY : Next Sector Group Address to be protected

Sector Group Protection Timing Diagram

Temporary Sector Group Unprotection Timing Diagram

VCC

tVCS

RESET

tVLHT

tVIDR

Address   SGAX   SGAX   SGAY

A6, A3, A2, A0

A1

CE

OE   TIME-OUT

WE

Data   60h   60h   40h   01h   60h

tOE
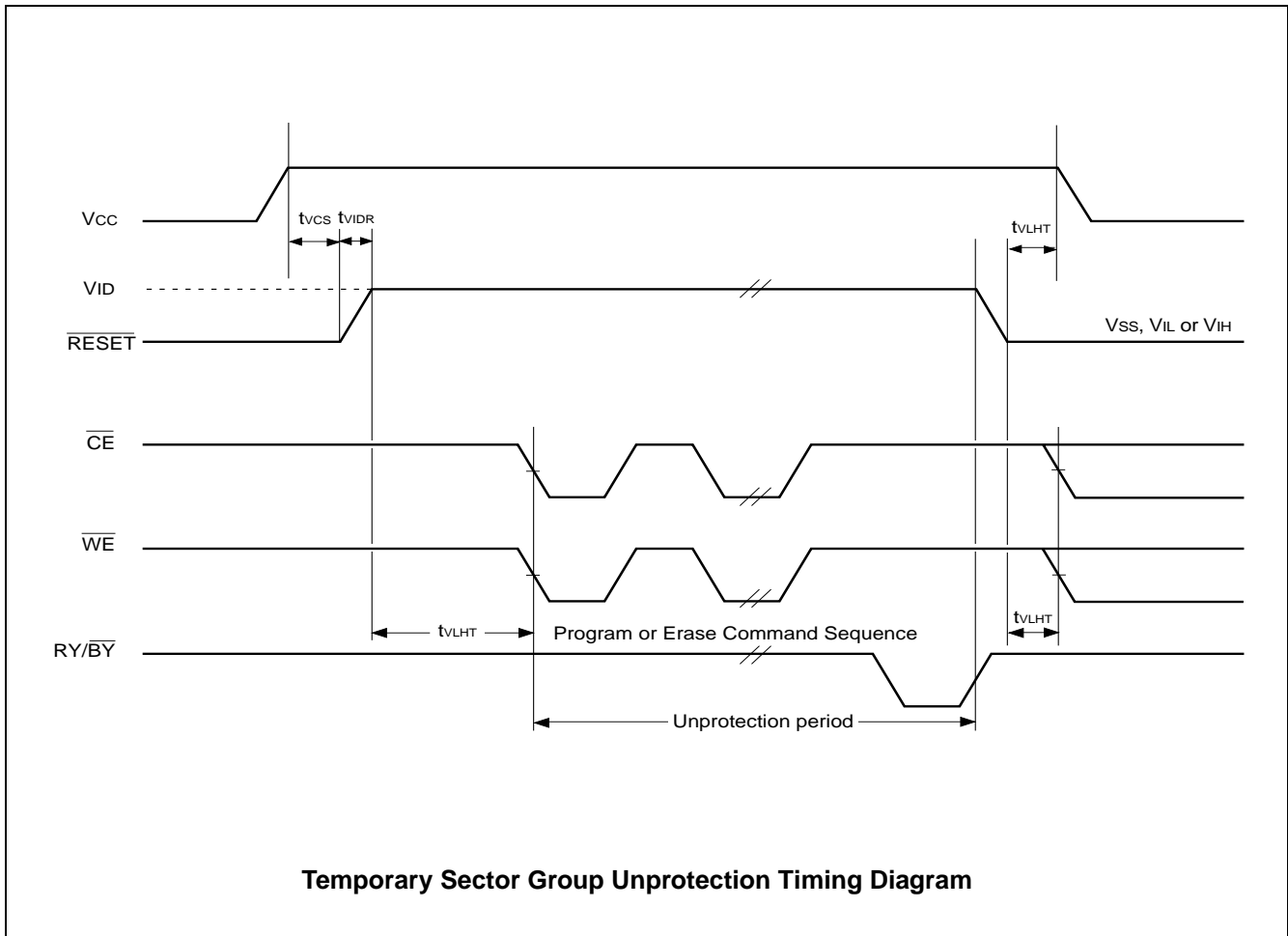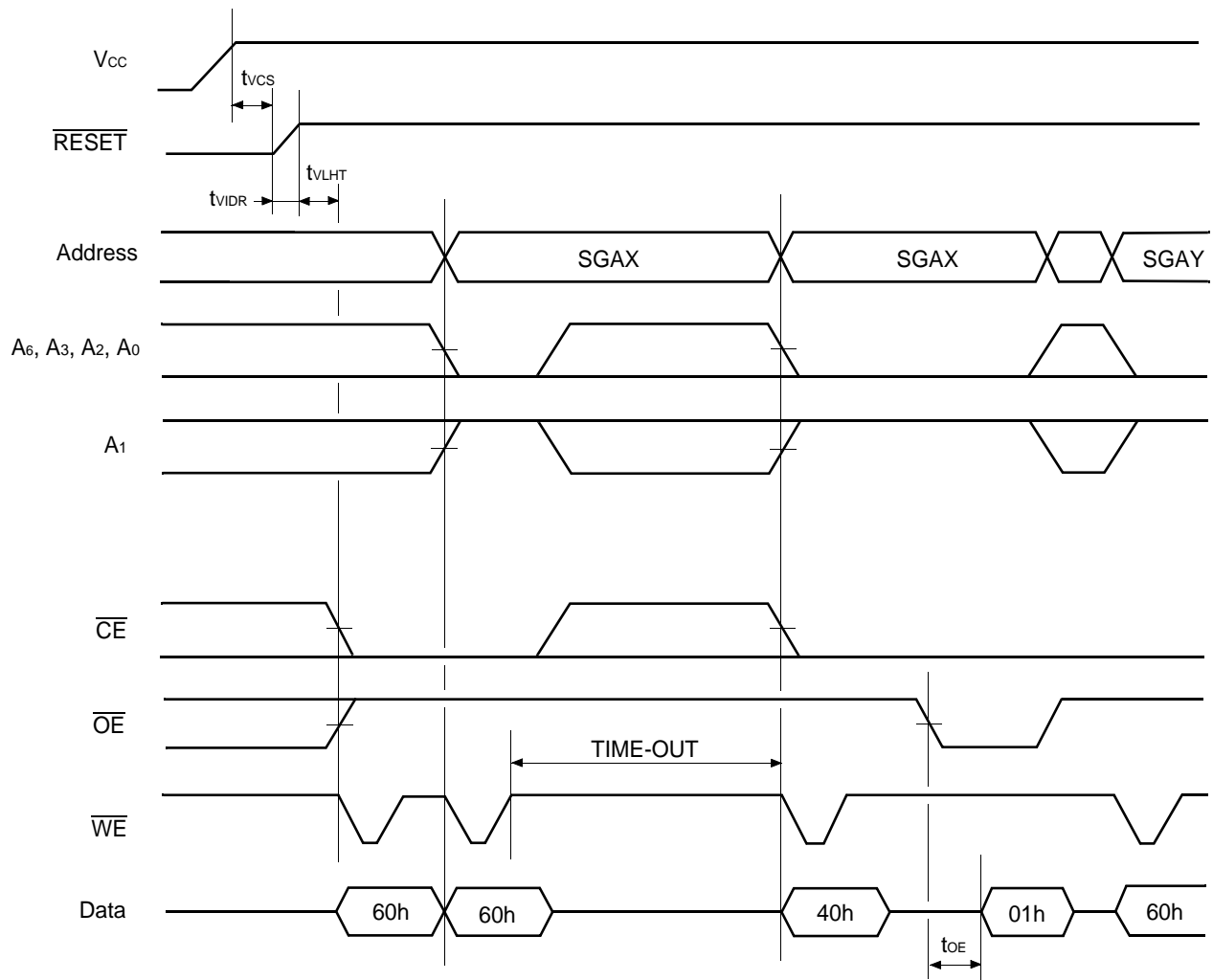
SGAX: Sector Group Address to be protected
SGAY : Next Sector Group Address to be protected
TIME-OUT : Time-Out window = 250 μs (Min)

Extended Sector Group Protection Timing Diagram
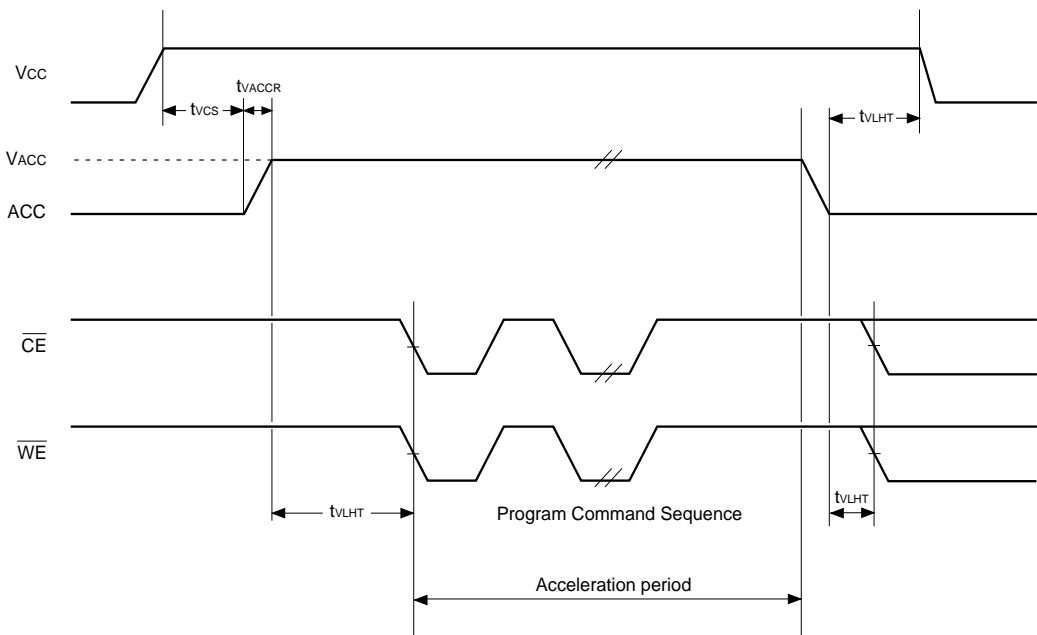
Accelerated Program Timing Diagram

■ FLOW CHART

EMBEDDED ALGORITHMS
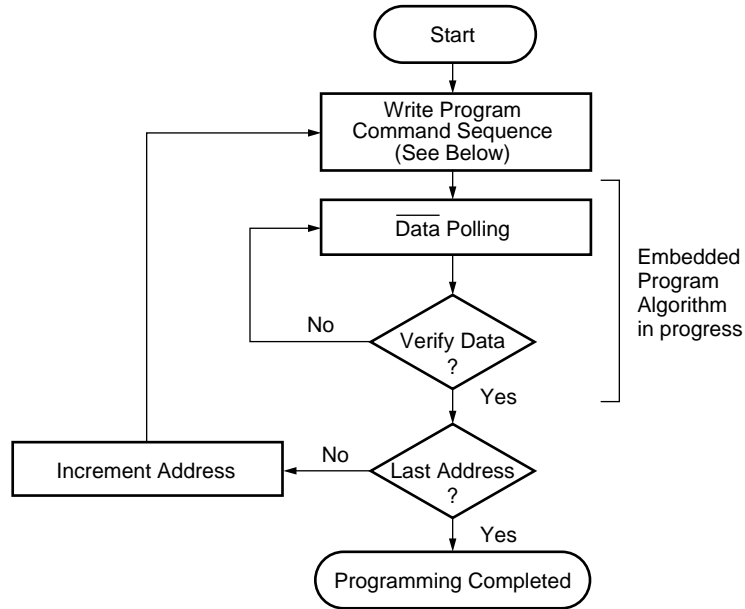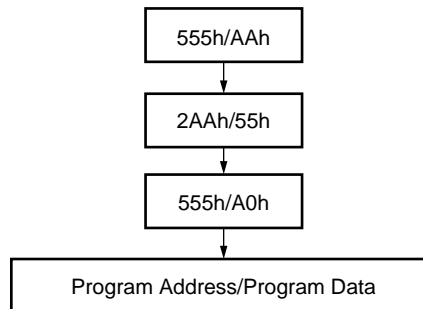
```
                        ┌─────────┐
                        │  Start  │
                        └─────────┘
                             │
                             ▼
                    ┌──────────────────┐
              ┌────▶│  Write Program   │
              │     │ Command Sequence │
              │     │   (See Below)    │
              │     └──────────────────┘
              │              │                    ┐
              │              ▼                    │
              │     ┌──────────────────┐          │
              │  ┌─▶│   Data Polling   │          │
              │  │  └──────────────────┘          │   Embedded
              │  │           │                    │   Program
              │  │           ▼                    │   Algorithm
              │  │ No   ╱ Verify Data ╲           │   in progress
              │  └─────◀    ?                     │
              │        ╲           ╱              │
              │              │ Yes               ┘
   ┌──────────────────┐  No  ▼
   │Increment Address │◀─╱ Last Address ╲
   └──────────────────┘  ╲     ?       ╱
                              │ Yes
                              ▼
                    ┌──────────────────────┐
                    │ Programming Completed │
                    └──────────────────────┘
```

Program Command Sequence (Address/Command):

```
        ┌──────────┐
        │ 555h/AAh │
        └──────────┘
             │
        ┌──────────┐
        │ 2AAh/55h │
        └──────────┘
             │
        ┌──────────┐
        │ 555h/A0h │
        └──────────┘
             │
   ┌───────────────────────────┐
   │ Program Address/Program Data │
   └───────────────────────────┘
```

Note : The sequence is applied for Word (×16) mode.
The addresses differ from Byte (× 8) mode.

Embedded Program™ Algorithm

MBM29PL32TM/BM₉₀/₁₀

EMBEDDED ALGORITHMS

```
        ┌─────────┐
        │  Start  │
        └────┬────┘
             ▼
     ┌─────────────────┐
     │  Write Erase    │
     │ Command Sequence│
     │   (See Below)   │
     └────────┬────────┘
              ▼
     ┌─────────────────┐                    ┐
  ┌─▶│  Data Polling   │                    │
  │  └────────┬────────┘                    │  Embedded
  │           ▼                             │  Erase
  │        ╱───────╲                        │  Algorithm
 No       ╱ Data = FFh╲                     │  in progress
  └──────◀   ?        ╲                     │
          ╲          ╱                      │
           ╲───┬───╱                        │
               │ Yes                        ┘
               ▼
     ┌─────────────────────┐
     │  Erasure Completed  │
     └─────────────────────┘
```

Chip Erase Command Sequence (Address/Command):

```
┌──────────┐
│ 555h/AAh │
└────┬─────┘
┌────▼─────┐
│ 2AAh/55h │
└────┬─────┘
┌────▼─────┐
│ 555h/80h │
└────┬─────┘
┌────▼─────┐
│ 555h/AAh │
└────┬─────┘
┌────▼─────┐
│ 2AAh/55h │
└────┬─────┘
┌────▼─────┐
│ 555h/10h │
└──────────┘
```
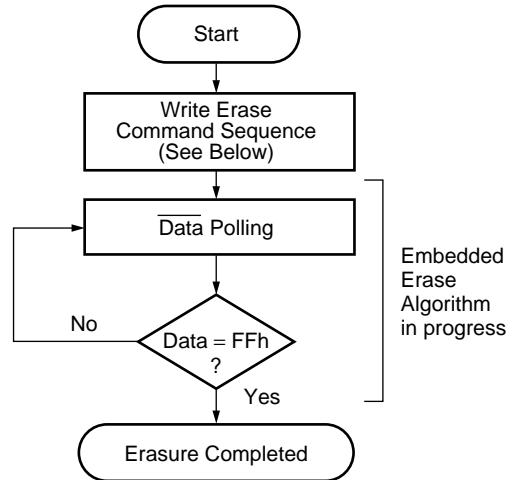
Individual Sector/Multiple Sector Erase Command Sequence (Address/Command):
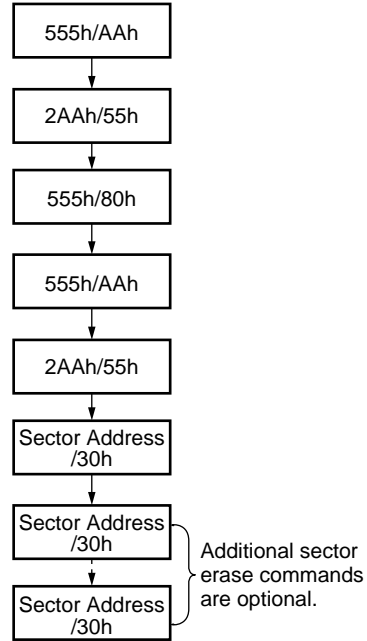
```
┌──────────────┐
│  555h/AAh    │
└──────┬───────┘
┌──────▼───────┐
│  2AAh/55h    │
└──────┬───────┘
┌──────▼───────┐
│  555h/80h    │
└──────┬───────┘
┌──────▼───────┐
│  555h/AAh    │
└──────┬───────┘
┌──────▼───────┐
│  2AAh/55h    │
└──────┬───────┘
┌──────▼───────┐
│Sector Address│
│    /30h      │
└──────┬───────┘
┌──────▼───────┐
│Sector Address│   Additional sector
│    /30h      │   erase commands
└──────┬───────┘   are optional.
┌──────▼───────┐
│Sector Address│
│    /30h      │
└──────────────┘
```

Note : The sequence is applied for Word (×16) mode.
The addresses differ from Byte (× 8) mode.

Embedded Erase™ Algorithm

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Start

Wait 4 μs after
issuing Program
Command

Read Byte
(DQ7 to DQ0)
Addr. = VA

DQ7 = Data? → Yes

No

DQ5 = 1? → No

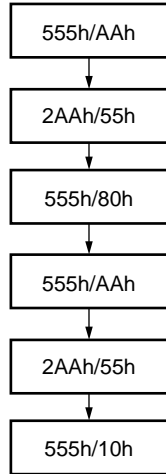Yes

Read Byte
(DQ7 to DQ0)
Addr. = VA

DQ7 = Data?
* → Yes

No

Fail   Pass
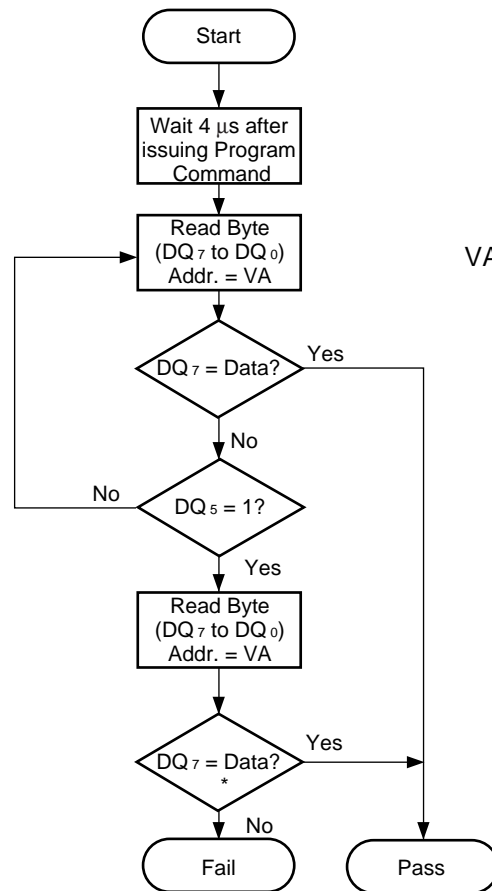
VA = Valid address for programming
   = Any of the sector addresses within
     the sector being erased during
     sector erase or multiple sector
     erases operation
   = Any of the sector addresses within
     the sector not being protected
     during chip erase operation

* : DQ_7 is rechecked even if DQ_5 = "1" because DQ_7 may change simultaneously with DQ_5.

Note : Data polling on sector-group protected sector may fail.

Data Polling Algorithm

```
                        ┌──────────┐
                        │  Start   │
                        └────┬─────┘
                             │
                   ┌─────────▼─────────┐
                   │  Wait 4 μs after  │
                   │ issuing Program   │
                   │    Command        │
                   └─────────┬─────────┘
                             │
                   ┌─────────▼─────────┐ *1
                   │ Read DQ7 to DQ0   │
                   │ Addr. = "H" or "L"│
                   └─────────┬─────────┘
                             │
                   ┌─────────▼─────────┐ *1
          ┌───────▶│ Read DQ7 to DQ0   │
          │        │ Addr. = "H" or "L"│
          │        └─────────┬─────────┘
          │                  │
          │               ╱──▼──╲          No
          │              ╱ DQ6 =  ╲──────────────┐
          │              ╲ Toggle? ╱             │
          │               ╲──┬──╱                │
          │                  │ Yes               │
          │               ╱──▼──╲                │
          │      No      ╱       ╲               │
          └─────────────╱ DQ5 = 1?╲              │
                        ╲         ╱              │
                         ╲──┬──╱                 │
                            │ Yes                │
                  ┌─────────▼─────────┐ *1, *2   │
                  │ Read DQ7 to DQ0   │          │
                  │ Addr. = "H" or "L"│          │
                  └─────────┬─────────┘          │
                            │                    │
                  ┌─────────▼─────────┐          │
                  │ Read DQ7 to DQ0   │          │
                  │ Addr. = "H" or "L"│          │
                  └─────────┬─────────┘          │
                            │                    │
                         ╱──▼──╲      No          │
                        ╱ DQ6 =  ╲───────────┐    │
                        ╲ Toggle? ╱          │    │
                         ╲──┬──╱             │    │
                            │ Yes            ▼    ▼
              ┌─────────────▼──────┐   ┌──────────────┐
              │  Program/Erase     │   │ Program/Erase│
              │  Operation Not     │   │  Operation   │
              │  Complete.Write    │   │  Complete    │
              │  Reset Command     │   │              │
              └────────────────────┘   └──────────────┘
```
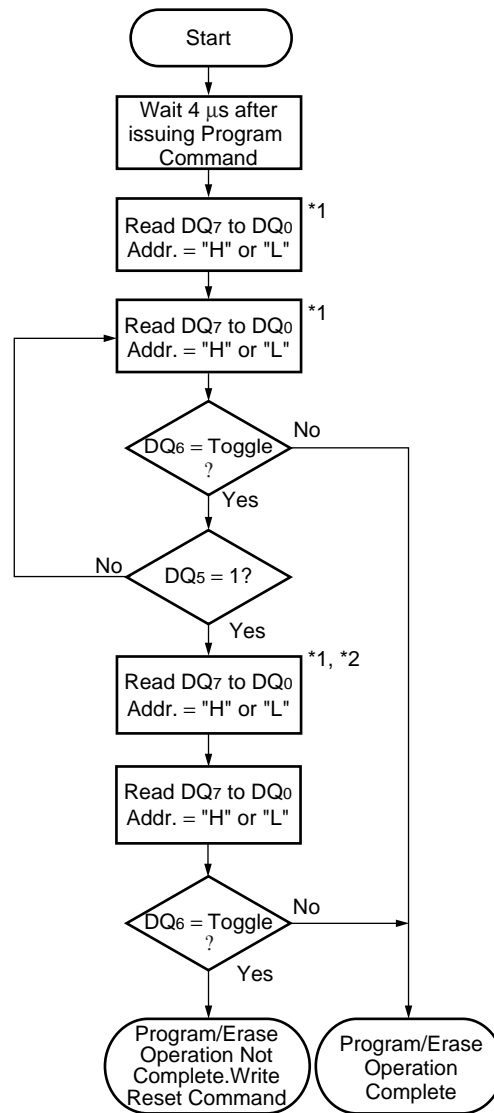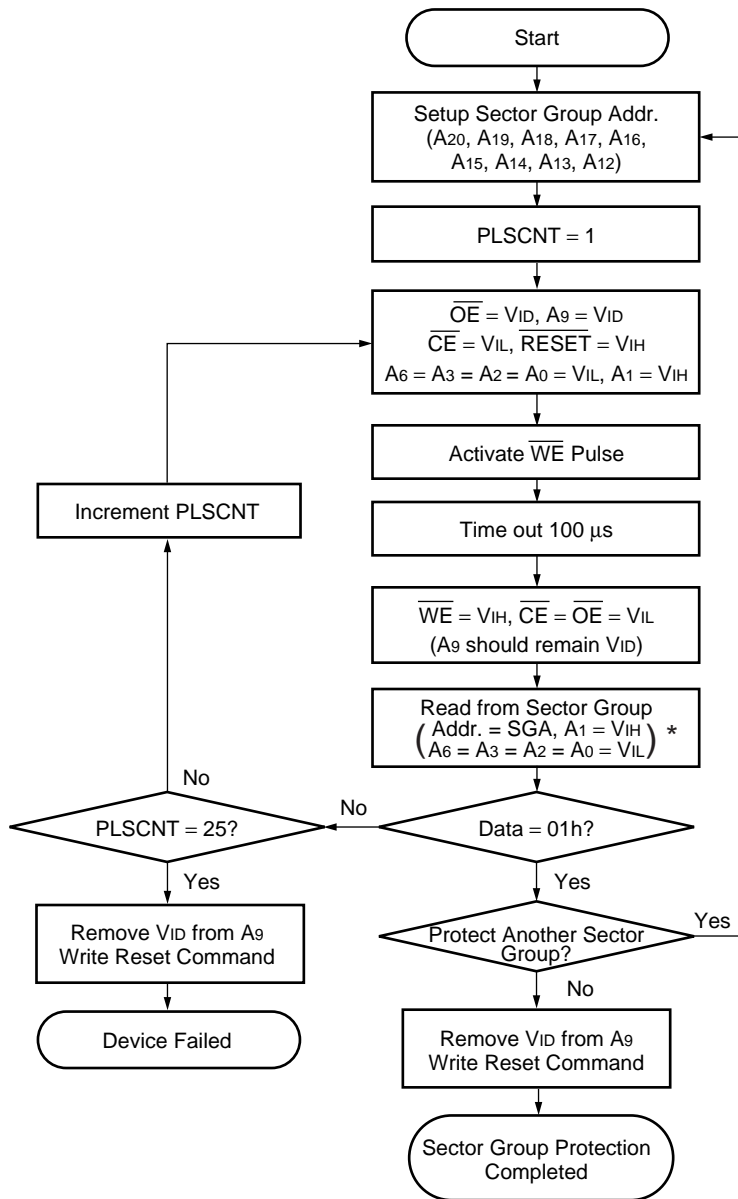
*1 : Read Toggle bit twice to determine whether it is toggling.

*2 : Recheck Toggle bit because it may stop toggling as DQ_5 changes to "1".

Toggle Bit Algorithm

Start

Setup Sector Group Addr.
(A_{20}, A_{19}, A_{18}, A_{17}, A_{16},
A_{15}, A_{14}, A_{13}, A_{12})

PLSCNT = 1

$\overline{OE}$ = V_{ID}, A_9 = V_{ID}
$\overline{CE}$ = V_{IL}, $\overline{RESET}$ = V_{IH}
A_6 = A_3 = A_2 = A_0 = V_{IL}, A_1 = V_{IH}

Activate $\overline{WE}$ Pulse

Increment PLSCNT

Time out 100 μs

$\overline{WE}$ = V_{IH}, $\overline{CE}$ = $\overline{OE}$ = V_{IL}
(A_9 should remain V_{ID})

Read from Sector Group
$\left(\begin{array}{c}\text{Addr.} = \text{SGA}, A_1 = V_{IH} \\ A_6 = A_3 = A_2 = A_0 = V_{IL}\end{array}\right)$ *

No

PLSCNT = 25?

No

Data = 01h?

Yes

Yes

Remove V_{ID} from A_9
Write Reset Command

Protect Another Sector
Group?

Yes

No

Device Failed

Remove V_{ID} from A_9
Write Reset Command

Sector Group Protection
Completed

* : A_{-1} is V_{IL} in Byte ($\times$ 8) mode.

Sector Group Protection Algorithm

```
                    ┌──────────────────────┐
                    │        Start         │
                    └──────────────────────┘
                               │
                               ▼
                    ┌──────────────────────┐
                    │   RESET = V_ID       │
                    │        *1            │
                    └──────────────────────┘
                               │
                               ▼
                    ┌──────────────────────┐
                    │   Perform Erase or    │
                    │  Program Operations   │
                    └──────────────────────┘
                               │
                               ▼
                    ┌──────────────────────┐
                    │   RESET = V_IH       │
                    └──────────────────────┘
                               │
                               ▼
                    ┌──────────────────────┐
                    │ Temporary Sector Group│
                    │ Unprotection Completed│
                    │         *2           │
                    └──────────────────────┘
```
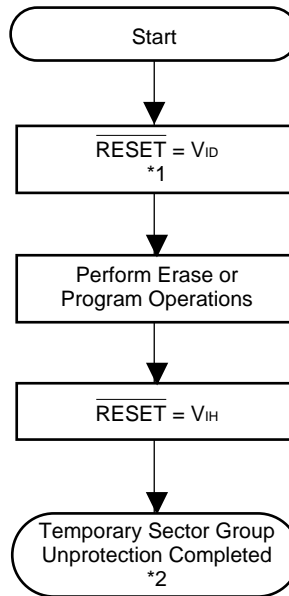
*1 : All protected sector groups are unprotected.

*2 : All previously protected sector groups are protected.

Temporary Sector Group Unprotection Algorithm

Start

$\overline{RESET} = V_{ID}$

Wait to 4 µs

Extended Sector Group Protection Entry? — No → Device is Operating in Temporary Sector Group Unprotection Mode

Yes

To Setup Sector Group Protection Write XXXh/60h

PLSCNT = 1

To Protect Sector Group Write 60h to Sector Address $(A_6 = A_3 = A_2 = A_0 = V_{IL}, A_1 = V_{IH})$

Increment PLSCNT

Time Out 250 µs

Setup Next Sector Group Address

To Verify Sector Group Protection Write 40h to Sector Address $(A_6 = A_3 = A_2 = A_0 = V_{IL}, A_1 = V_{IH})$

Read from Sector Group Address $(A_6 = A_3 = A_2 = A_0 = V_{IL}, A_1 = V_{IH})$

PLSCNT = 25? — No (up to Increment PLSCNT)

Data = 01h? — No → PLSCNT = 25?

Yes (PLSCNT = 25?) → Remove V_{ID} from $\overline{RESET}$ Write Reset Command → Device Failed

Yes (Data = 01h?) → Protection Other Sector Group?

Protection Other Sector Group? — Yes → Setup Next Sector Group Address

No → Remove V_{ID} from $\overline{RESET}$ Write Reset Command

Sector Group Protection Completed

Extended Sector Group Protection Algorithm

FAST MODE ALGORITHM

Start

555h/AAh

2AAh/55h

555h/20h

} Set Fast Mode

XXXh/A0h

Program Address/Program Data

Data Polling

Verify Data? — No

Yes

Last Address ? — No → Increment Address

Yes

Programming Completed

} In Fast Program

XXXh/90h

XXXh/F0h

} Reset Fast Mode
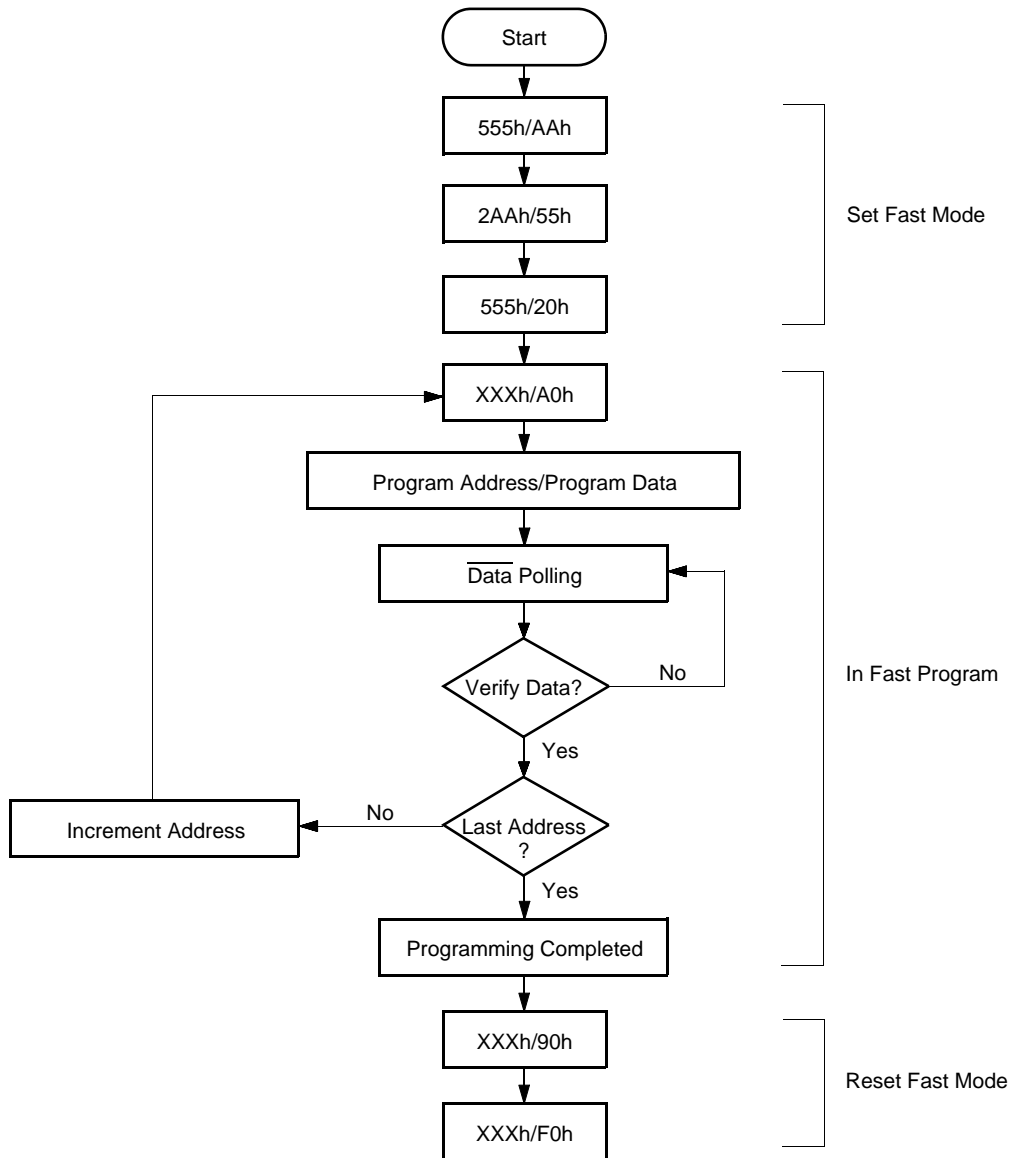
Notes : • The sequence is applied for Word (×16) mode.
      • The addresses differ from Byte (× 8) mode.

Embedded Program™ Algorithm for Fast Mode

■ ORDERING INFORMATION

Part No.	Package	Access Time (ns)	Remarks
MBM29PL32TM90TN	48-pin, plastic TSOP (1) (FPT-48P-M19) (Normal Bend)	90 ns	Top Sector
MBM29PL32TM10TN		100 ns	
MBM29PL32TM90PBT	48-ball, plastic FBGA (BGA-48P-M20)	90 ns	
MBM29PL32TM10PBT		100 ns	
MBM29PL32BM90TN	48-pin, plastic TSOP (1) (FPT-48P-M19) (Normal Bend)	90 ns	Bottom Sector
MBM29PL32BM10TN		100 ns	
MBM29PL32BM90PBT	48-ball, plastic FBGA (BGA-48P-M20)	90 ns	
MBM29PL32BM10PBT		100 ns	

MBM29PL32TM/BM   90   TN

PACKAGE TYPE
TN = 48-Pin Thin Small Outline Package (TSOP(1) Standard Pinout)
PBT = 48-Ball Fine pitch Ball Grid Array Package (FBGA)

SPEED OPTION
90 = 90 ns access time
10 = 100 ns access time

DEVICE NUMBER/DESCRIPTION
32 Mbit (4M × 8/2M × 16) MirrorFlash with Page Mode, Boot Sector
3.0 V-only Read, Program, and Erase

■ PACKAGE DIMENSIONS

48-pin plastic TSOP(1)
(FPT-48P-M19)

Note 1) * : Values do not include resin protrusion.
Resin protrusion and gate protrusion are +0.15(.006)Max(each side).
Note 2) Pins width and pins thickness include plating thickness.
Note 3) Pins width do not include tie bar cutting remainder.

LEAD No.

INDEX

Details of "A" part

0.25(.010)

0~8°

0.60±0.15
(.024±.006)

20.00±0.20
(.787±.008)

* 18.40±0.20
(.724±.008)

"A"

0.10(.004)

* 12.00±0.20
(.472±.008)

1.10 +0.10 −0.05
(.043 +.004 −.002)
(Mounting height)

0.50(.020)

0.10±0.05
(.004±.002)
(Stand off height)

0.17 +0.03 −0.08
(.007 +.001 −.003)

0.22±0.05
(.009±.002)

0.10(.004) Ⓜ
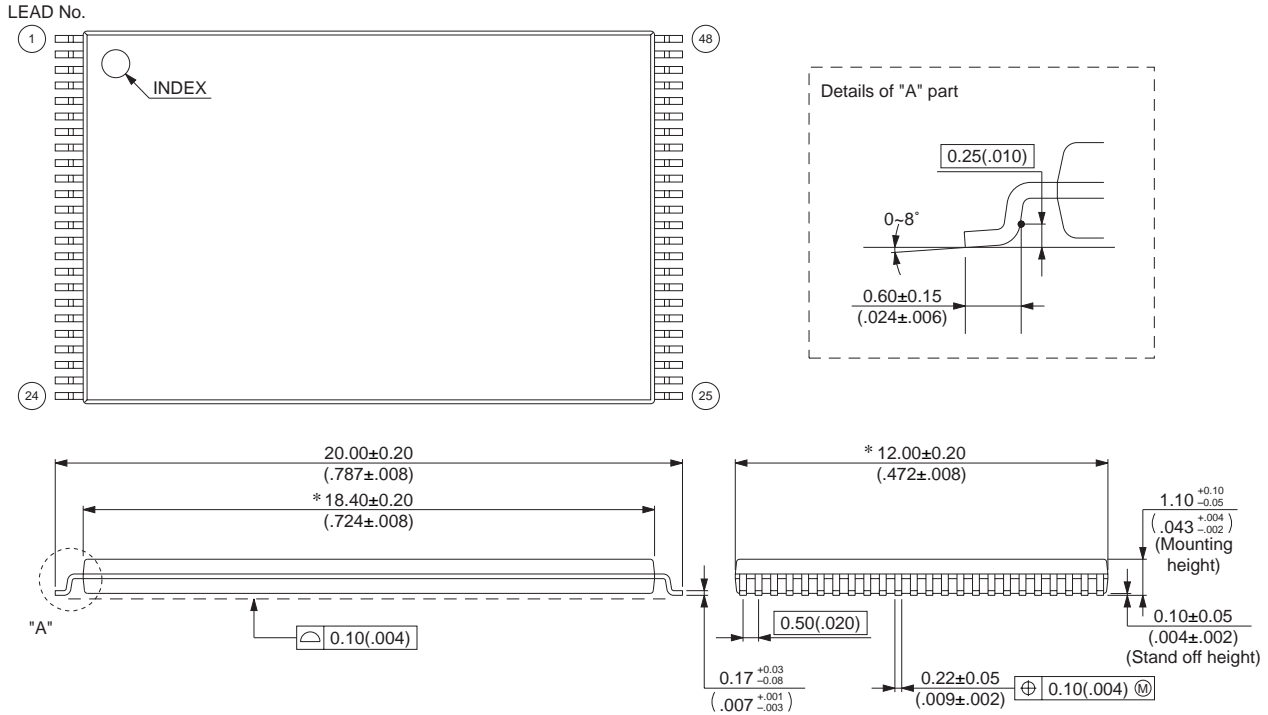
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Dimensions in mm (inches)
Note : The values in parentheses are reference values.

(Continued)

66

(Continued)

48-ball plastic FBGA
(BGA-48P-M20)

8.00±0.20(.315±.008)

6.00±0.20
(.236±.008)

(INDEX AREA)

1.08 $^{+0.12}_{-0.13}$ (.043 $^{+.003}_{-.005}$)
(Mounting height)

0.38±0.10(.015±.004)
(Stand off)

5.60(.220)

0.80(.031)TYP

4.00(.157)

6
5
4
3
2
1

H   G   F   E   D   C   B   A

48-ø0.45±0.05
(48-ø.018±.002)

⊕ | ø0.08(.003) | Ⓜ

0.10(.004)
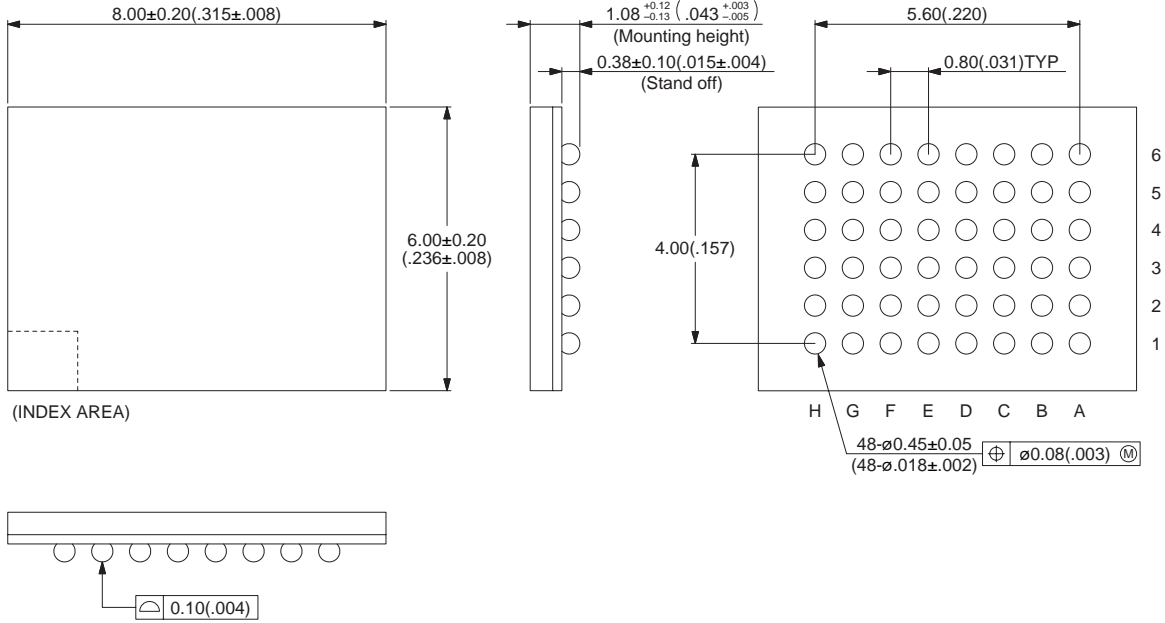
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Dimensions in mm (inches)
Note : The values in parentheses are reference values.

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